ADV11-A, KWV11-A, AAV11-A, DRV11
user's manual
ADV11-A, KWV11-A, AAV11-A, DRV11
user's manual

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CHAPTER 1
INTRODUCTION

1.1 GENERAL
This manual contains information necessary for the operation, installation, and maintenance of the family of real-time analog and digital I/O devices which DEC provides as options for the LSI-11 Processor, i.e., the ADV11-A Analog-to-Digital Converter, the KWV11-A Real-Time Clock, the AAV11-A Digital-to-Analog Converter, and the DRV11 Parallel Line Interface. Operating information for each device is provided in a chapter specific to that device which includes functional description, specifications, theory of operation, and programming background. Installation and maintenance information is provided for all units in Chapter 6.

All members of the LSI-11 real-time I/O family are designed to interface between the processor and analog or digital signals in the world external to the processor. All devices are configured on one quad or double-height board designed to mount in an LSI-11 backplane or expander box and to receive power from LSI-11 supplies. All communicate with the LSI-11 bus and receive interrupt priority as a function of their location in the backplane. Finally, all have facilities to permit users to assign device addresses, and where appropriate, interrupt vector locations.

A number of recommendations are made in this text regarding specific interfacing configurations and general good practice. However, no specific interfacing claims are made over and above those expressed in the general specifications for each module. The responsibility for connecting DEC modules to external equipment rests ultimately with the user.

1.2 REFERENCES

- Microcomputer Handbook (EB-06583 76 09/53)
- LSI-11 Bus Specification
CHAPTER 2
ADV11-A ANALOG-TO-DIGITAL CONVERTER

2.1 GENERAL DESCRIPTION
The ADV11-A is a 12-bit successive-approximation analog-to-digital converter with built-in multiplexer and sample-and-hold for use on the LSI-11 bus. The multiplexer section accommodates 16 single-ended or 8 quasi-differential inputs, and the converter section utilizes a patented auto-zeroing design that measures the sampled signal with respect to the offset of its own internal circuitry and thus effectively cancels out its own offset error contributions to the measurement.

A/D conversions are initiated either by program command, clock overflow, or external events as determined by program control of the ADV11-A’s Control/Status Register (CSR). The clock overflow command is supplied by the KWV11-A clock option. External event inputs may originate directly from user equipment or from the Schmitt trigger output on the KWV11-A clock. Digital A/D conversion data is routed through a buffer register to the LSI-11 for programmed transfer into memory. This buffering optimizes the throughput rate of the converter by allowing data from one conversion to be transferred to the processor after a subsequent conversion begins.

A vernier offset digital-to-analog converter is included in the ADV11-A’s analog circuitry to facilitate very accurate program-controlled trimming of the A/D’s offset. Three test signals – two dc levels and one bipolar triangular waveform – are available for use on any channel input. The triangular wave can be used in conjunction with diagnostic software and the vernier DAC to produce extremely thorough and precise analog testing.

2.2 SPECIFICATIONS

2.2.1 Electrical (@ 25º C unless otherwise specified)

Inputs

| Analog Input Protection | Fusible resistor guaranteed to open at ±85 V within 6.25 seconds. Guaranteed not to open from -20 V to +15 V at the input. Overload affects no components other than the fusible resistor on the overloaded channel; no other channels are affected. |
| Logic Input Protection   | Fusible resistor guaranteed to open at ±25 V within 6.25 seconds. Guaranteed not to open from -3 V to +8 V at the input. |
| Analog Input Full Scale Range (FSR) | 10.24 V bipolar (-5.12 V to +5.12 V) |
Inputs (Cont)

Analog Input
Dynamic Resistance
(/Vin/ ≤ 5.12 V)
Analog Input Bias Current
(/Vin/ ≤ 5.12 V)
Logic Input Voltages
Logic Input Currents
Logic Input Rise/Fall Time
100 MΩ, minimum
50 nA, maximum
Low = 0.0 to +0.7 V; high = +2 V to +5 V
Low = -6.8 mA at 0 V in.; high = +1.3 mA at +5 V in
400 ns, maximum

2.2.2 Coding

A/D Converter
Resolution
Format
12 bits, binary weighted
Parallel offset binary, right justified

<table>
<thead>
<tr>
<th>Input Voltage</th>
<th>Output Code</th>
</tr>
</thead>
<tbody>
<tr>
<td>+FS-1 LSB</td>
<td>7777</td>
</tr>
<tr>
<td>0</td>
<td>4000</td>
</tr>
<tr>
<td>-FS</td>
<td>0</td>
</tr>
</tbody>
</table>

(FS = 5.12 V; 1 LSB = 2.5 mV)

Vernier D/A
Resolution
Format
8 bits, binary weighted
Offset binary encoded

<table>
<thead>
<tr>
<th>Input Code</th>
<th>Approximate Offset Voltage</th>
</tr>
</thead>
<tbody>
<tr>
<td>377</td>
<td>+2.5 A/D LSB (+6.4 mV)</td>
</tr>
<tr>
<td>200</td>
<td>0</td>
</tr>
<tr>
<td>0</td>
<td>-2.5 A/D LSB (-6.4 mV)</td>
</tr>
</tbody>
</table>

2.2.3 Performance

Gain Error
Offset Error
Differential Linearity
Integral Linearity
Adjustable to zero
Adjustable to zero
No skipped states; no states wider than 2 LSB. 99% of state- widths ± 1/2 LSB
±1 LSB, maximum non-linearity (referenced to end points)
Performance (Cont)

Temperature Coefficients
Gain = 6 ppm per degree C
Linearity = 2 ppm of full-scale range per degree C
Offset = 7.5 ppm of full-scale range per degree C

Noise
Module = 0.4 LSB rms; 2 LSB peak
System = 1/2 LSB rms; 2 LSB peak

Warm-Up Time
5 minutes, maximum

2.2.4 Timing

External Start
Low level pulse, 50 ns minimum to 10 μs maximum; conversion starts on leading edge

Synchronization
0 to T

Conversion Time
16T
(T = clock period = 2.14 μs ± 6%)

Transition Interval*
9 μs ± 12%

Sample and Hold
Aperture Delay = 200 ns
Aperture Uncertainty = 2 ns

2.2.5 Test Signals
The ADV11-A provides three output voltages for test purposes:

1. Positive dc level, +4.4 V (±15%)
2. Negative dc level, −4.4 V (±15%)
3. Triangular wave, 15 Hz nominal (±15%)

2.2.6 Environmental (Ref: DEC STD 102, class B)

2.2.7 Power Requirements

+5 Vdc ±5% @2.0 A, maximum
+12 Vdc ±3% @450 mA, maximum

2.3 FUNCTIONAL DESCRIPTION
The ADV11-A performs its function in seven successive steps:

1. It enables the specified channel.
2. It samples 1 of 16 single-ended (or 1 of 8 differential) analog input channels specified by the control program long enough to acquire a reliable internal reference equivalent.
3. It accepts a command to perform an A/D conversion.
4. It holds the sampled reference equivalent during 12 successive interrogation intervals.

*Reacquisition interval between end of conversion or channel change and start of new conversion.
5. When the least significant bit has been resolved in the Successive Approximation Register (SAR), the ADV11-A transfers the contents of the now-filled SAR to the DATA Buffer Register (DBR) where that data can be accessed by the processor.

6. It informs the processor that conversion data is available.

7. It reacquires and tracks the programmed channel.

These steps are implemented in the ADV11-A by components that can be grouped together in four functional categories:

1. Channel selection

2. A/D conversion

3. Processor/ADV11-A interface

4. Control logic that coordinates the above steps with respect to one another and to the needs of the processor.

These categories are discussed below.

2.3.1 Channel Selection

Channel selection is accomplished under program control by two 8-channel multiplexers and is a function of the data asserted in bits 8 through 11 of the Control/Status Register (CSR). Each of the 16 analog input channels is routed to the single output channel through a MOS field-effect transistor which acts as a normally-open switch. During the sample interval, the data pattern in CSR bits 8 through 11 selects one of these transistors and causes it to change from a condition of nearly infinite resistance (1 GΩ or more) to one of very low resistance (1000 Ω or less). Since in the selected state the transistor conducts current within the ±5.12 V limits equally well in both directions, it now functions as a closed switch, effectively routing to the output line whatever analog signal is connected to its input.

2.3.2 A/D Conversion

A/D conversions can be initiated in three ways: under program control, on overflow from the KWV11-A Real-Time Clock, or on external input. When a conversion is completed or the control program writes a multiplexer address into the CSR, the control logic initiates the Transition Interval – a delay of about 9 μs to allow the multiplexer adequate selection and settling time and to permit a valid representation of the signal level to be established in the sample circuit. If no A/D Start signal has occurred by the time the Transition Interval has elapsed, the sample circuit merely follows the signal transmitted to it through the selected multiplexer channel and waits for an A/D Start signal. When an A/D Start signal occurs – or at the end of the Transition Interval if A/D Start was previously generated by the writing of the CSR GO bit – the sample and hold circuits are switched to hold, sustaining the sampled level for the next step. The multiplexer output is then set to its hold condition, i.e., to ground if the single-ended (S.E.) input is set low for single-ended measurement, to the second differential input (return line) if the S.E. input is not set low. Note that if an external or clock start signal occurs during the Transition Interval, conversion starts immediately without waiting for the Transition Interval to be completed. Bit 15 of the CSR (AD ERROR) is set, however, and an interrupt is generated if bit 14 (error interrupt enable) is set – alerting the program that conversions are occurring too fast and are consequently liable to be in error.
Figure 2-1  ADV11-A Functional Block Diagram
Under normal conditions, it is not until the Transition Interval is complete that the measurement process is begun. The Successive Approximation Register (SAR) is cycled through 13 states by the clock. In the first state its output code involves only the most significant bit (MSB) of the 12-bit SAR word. This output code causes the feedback digital-to-analog converter (DAC) to generate an output equivalent to that produced by the hold circuits in response to a sample voltage of 0. The DAC output is summed with that produced by the hold circuits and with that coming from the grounded multiplexer output (single-ended mode) or from the second differential input (quasi-differential mode). If the current from the summing node is negative, the first approximation was too low, and the comparator signals the SAR to maintain the state of bit 11 and repeat the process with bit 10. If the current from the summing node is positive, the first approximation was too high and the SAR changes the state of bit 11 before cycling into the second approximation. This process continues until all 12 bits in the word have been set, tested, and if necessary, changed. The 13th state (end of conversion, or EOC) indicates that the measurement is complete and that the SAR now contains an offset binary equivalent of the sampled voltage and may therefore be transferred to the processor. EOC causes the sample and hold circuits to return to the sample mode and to reset the SAR, preventing further SAR activity until the occurrence of the next hold condition.

Note that because the reference point against which the sample voltage is compared is at the output of the multiplexer itself rather than internal to the sample and hold circuits, all offset voltages generated by the intervening circuits are common to both sample and hold conditions and are therefore cancelled out of any measurement. In single-ended mode, grounding the multiplexer output (and thereby establishing this reference point) is identified as auto-zeroing the converter.

2.3.3 Interface Functions
In addition to stopping the SAR clock and reestablishing the sample mode, the end-of-conversion signal also initiates the process that causes the SAR data to be transferred to the processor. Since this operation takes a finite amount of time which would interfere with subsequent measuring operations, the SAR data is first transferred to a holding device, the Data Buffer Register (DBR), where it will remain until the processor can be notified to read the conversion data for processing. In the meantime, the channel selection and A/D conversion circuits can begin the next measurement as dictated by Control/Status Register (CSR) bit conditions controlled by the processor.

Included in the ADV11-A interface is an extension of the DBR designed to accept 8-bit write information from the BUS DATA/ADDRESS lines. This buffer permits programmed setting of the Vernier DAC (see Paragraph 6.2.2.3). Also included are transceivers that connect the bi-directional BUS DATA lines to the LSI-11 Bus DATA/ADDRESS lines. Associated with these transceivers are switches that permit assigning device and vector addresses to any given ADV11-A.

2.3.4 Control
As the above discussion suggests, a large number of signals must be precisely orchestrated each time the ADV11-A executes a conversion. The control logic contains an assortment of gates, latches, read-only memories, and timing circuits designed to assure that multiplexer channels are properly selected, sample durations are of adequate length, conversions are not initiated during uncompleted previous conversions, etc. In general, this logic precludes the need for the user to attend to any but the most elementary details of the conversion process, e.g., making necessary connections to the system and writing control programs that make appropriate use of the CSR.

2.4 USER INTERFACING

2.4.1 Analog Inputs

2.4.1.1 Single-Ended Mode* – Single-ended analog input signals for the ADV11-A may be of two types, grounded and floating. A grounded input is one whose level is referenced to the ground of the instrument that is producing it, as illustrated in Figure 2-2. Since the instrument may be located at a

*The ADV11-A is factory-set for differential mode. Single-ended mode must be selected as described in Paragraph 2.4.3.3.
distance from the computer, there may be some voltage difference between the instrument ground and the computer ground. The voltage seen by the ADV11-A will be the sum of the undesired ground difference voltage and the desired instrument signal voltage. In cases where such differences are encountered, they can be minimized by plugging the instrument into an ac outlet as close as possible to that providing power to the computer. Do not run a wire from user's ground to the ADV11-A analog ground. Such a wire can cause ground loop currents which affect results not only on the input channel in question, but also on other channels.

![Diagram](image)

Figure 2-2  Single-Ended Input Referenced to User's Ground

A floating input is one whose signal voltage is developed with respect to a point not connected to ground, as illustrated in Figure 2-3. The identifying characteristic of a floating source is that connecting the signal return to the ADV11-A ground does not result in a current path between the ADV11-A ground and the instrument ground.

Note that the return of a floating input must be connected to one of the ADV11-A's analog ground terminals (see Figure 2-3). Ground points may be shared among channels, as illustrated by the battery-powered sources in Figure 2-3.

2.4.1.2 Quasi-Differential Mode – The "quasi" prefix in "quasi-differential" can best be explained in the context of a preliminary review of true differential operation. A true differential input involves two signal lines connected to a differential amplifier in such a way that the output of the device is a function of the instantaneous difference between the voltages on the two signal lines. One advantage of such a configuration is illustrated in Figure 2-4.

Figure 2-4(a) assumes a single-ended generating device that produces a signal, $V_s$, with respect to its ground and is situated sufficiently far from the receiving device for a significant noise voltage, $V_n$, to be developed in the power distribution ground lines. The result is that, at any given instant, the differential amplifier in the receiving device sees both the signal voltage and the noise voltage. Its output, $V_o$, is a function of $V_s + V_n$ and is in error with respect to $V_s$ alone.
Figure 2-3  Floating ADV11-A Input Signals

Figure 2-4(b) illustrates the same device connected in true differential mode. The same noise voltage exists in the power distribution ground system, but this time the generating device ground is connected directly to the negative input of the receiving differential amplifier. Since the instantaneous noise voltage is common to both the + and the - inputs, it is cancelled out of the final amplifier output. \( V_0 \) now provides a valid representation of \( V_s \) alone.

Figure 2-5 illustrates the ADV11-A operating in the quasi-differential mode.

The major contrast between true differential operation as described above and the operation of the ADV11-A in differential mode is that in the latter, the two sides of the signal are not simultaneously input to a differential amplifier. Rather, their difference is established by a sequential operation that first samples the voltage at one of the two inputs and then, holding this value fixed, in effect subtracts from it the voltage at the second input. For near dc conditions, this procedure produces a result like that of true differential operation – that is, the output is a function of the difference between the two input voltages, and common mode voltages are cancelled out. But, since there is a significant time lapse between taking the sample and completing the final approximation, a possibility for error is introduced by the ADV11-A that increases as a function of common mode signal frequency. The result

2-8
is that the common mode rejection ratio, while essentially infinite at dc, rolls off for ac signals, and is about 40 dB at 60 Hz line frequency. In addition, since the holding action of the sample-and-hold circuit is only in effect on the first (non-inverting, signal) input but not on the second (inverting, return) input, the voltage rate of change on the second input should be kept below 25 mV/ms. This is the slope that results in a quarter-LSB change during the conversion interval. Such a rate of change corresponds to 125 mV, peak-to-peak at 60 Hz line frequency. This dynamic response difference between the two inputs requires us to distinguish the ADV11-A’s differential mode from true differential operation. Hence the term “quasi-differential.”

Figure 2-4  Single-Ended Versus True Differential Input Modes

### 2.4.2 Avoiding Spurious Signals

As a preliminary step, confirm that the computer power supply ground is connected to power line (earth) ground. If continuity checks reveal no such connection, attach a length of 12-gauge wire between the power supply ground and a convenient point associated with earth ground. (All DECLAB 11/03 systems are provided with this connection at the factory.)

#### 2.4.2.1 Twisted Pair Input Lines – The effects of magnetic coupling on the input signals may be reduced for floating single-ended or differential inputs by twisting the signal and return lines in the input cable. If the inductive pickup voltages of the two leads match, the net effect seen at the ADV11-A input is zero. Use of twisted pairs has no effect with a single-ended non-floating signal (referenced to ground at the instrument end).
FOR dc CONDITIONS:
$$V_0 = V_1 - V_2 * (V_s + V_n) - V_n = V_s$$

FOR ac CONDITIONS:
$$V_0 = V_1(t_1) - V_2(t_2) + V_n(t_1) + [V_n(t_1) - V_n(t_2)]$$

NOTE:
Solid switch positions indicate sample state ($t_1$); dotted positions indicate hold state ($t_2$)

Figure 2-5 ADV11-A Quasi-Differential Mode
2.4.2.2 **Shielded Input Lines** – The effects of electrostatic coupling on the input signals may be reduced by shielding the signal wires. This is especially important if the instrument or transducer has high source impedance. To prevent the shield from carrying current and thus developing ground loop voltages within the ADV11-A, connect it to ground at the instrument end only.

2.4.2.3 **Allowing for Input Settling with High Source Impedance** – All solid-state multiplexers inject a small amount of charge into their input lines when changing channels, causing a transient error voltage that is discharged by the input signal’s source impedance. The ADV11-A shares this characteristic, and also injects a small charge into the selected input line at the end of each conversion when the auto-zero switch is turned off (see Paragraph 2.3.2). After any channel change and after any conversion, the ADV11-A’s control logic allows a 9 µs interval (identified as the Transition Interval) during which conversions cannot start without generating error conditions. Normally, this is sufficient time for the input transient to settle out. However, more time may be needed when the multiplexer is switching into an input channel with high source impedance, particularly when large amounts of shunt capacitance exist in the interconnecting cables. Source impedance/cable shunt capacitance products greater than 1 µs should be avoided whenever conversions are to be made at maximum rate with less than 1/2 LSB error. This means that cable shunt capacitance for a 1000 Ω source should not exceed 1000 pF (10³ × 10⁻⁹ = 10⁻⁶), that shunt capacitance for a 100 Ω source should not exceed 0.01 µF (10² × 10⁻⁴ = 10⁻²), etc. Assuming twisted pair cable capacitance of 50 pF/foot, these constraints translate into a maximum run of 20 feet from a 1000-Ω source, 200 feet from a 100-Ω source, etc. Note that these values are consistent with good practice for avoiding noise pickup in long cable runs. Note also that settling errors can be eliminated by increasing the time between conversions or incorporating a software delay between channel changes and program start commands.

2.4.3 **Connections**

Figure 2-6 illustrates the location of user connectors and switches on the component side of the ADV11-A board.

Analog input signals are input to the ADV11-A through the 40-pin connector. Pin assignments for the connector are shown in Figure 2-7. The proper Berg-to-Berg cable is the BC08R; the proper Berg to prepared open-ended cable is the BC04Z. (See Maintenance chapter for further information.)

2.4.3.1 **Distribution Panel** – Figure 2-8 shows an H322 Distribution Panel that is connected on the rear to the ADV11-A Berg connector and on the front provides easily identifiable and conveniently accessible barrier strip connections for user apparatus. Each H322 accommodates two ADV11-As or one ADV11-A and one other single-connector device. The ADV11-A is shipped with decal sets that specifically identify ADV11-A inputs and outputs. Note that the H323-B Potentiometer Box may not be used with the ADV11-A. (See Maintenance chapter for appropriate potentiometer box circuit.)

2.4.3.2 **External and Clock Starts** – The external start signal line, pin B of the Berg connector or TAB S (see Figures 2-6 and 2-7), is a TTL-compatible input that presents five unit loads (8.0 mA) to any driving output. Conversions start on the high-to-low transitions of this signal.

In most cases, the external start signal will be produced by a grounded (non-floating) pulse generator or logic circuitry located in a grounded instrument. The return path for the External Start signal will be through the power line ground system. For this reason, ground differences between source and computer should be minimized to prevent spurious start pulses due to ground noise. In no case should a separate return line be run between grounded source and the computer ground. Only with floating devices should return lines be run between source logic ground and logic ground pins on the ADV11-A Berg connector. External devices that require buffering can be interfaced to the ADV11-A through Schmitt Trigger 1 of the KWV11-A clock (ST1). Connection is made by means of a DEC 7010771 type jumper (Figure 2-9) to TAB S (Figure 2-6) of the ADV11-A.
Conversions that must be initiated in consequence of time intervals or on every nth external event may be triggered from the KWV11-A through a DEC 7010771 type jumper connected from the clock output tab (CLK) to the ADV11-A clock overflow tab (C).

2.4.3.3 Mode Control – The ADV11-A is equipped with jumper lugs (see Figure 2-6) that permit changing operating mode from quasi-differential (no connection) to single-ended (jumper installed). The single-ended mode can also be selected by connecting Berg connector pin C to logic ground. This alternative is provided to permit convenient external mode selection in installations that require frequent alternation between one mode and the other.

2.4.4 Vector and Address Selection – Device and vector addresses are assigned to the ADV11-A by means of two switch packs (S2 and S1, Figure 2-6). S2 is a pack containing 10 single-pole/single-throw switches, numbered 1–10, that communicate with data lines BDAL 2–11. Assuming BDAL lines 12–15 to be set by the processor to 1, S1 permits assigning any address between 170000 and 177774. The recommended address for the ADV11-A Status Register is 170400, set as illustrated in Figure 2-10(a). The Data Buffer Register automatically receives the next even address following that assigned to the CSR.
Figure 2-7  ADV11-A 40-Pin Connector Pin Assignments

Figure 2-8  H322 Distribution Panel

The A/D done interrupt vector address is set by means of S1, an 8-switch pack of which only six switches are utilized. These switches communicate with BDAL lines 3 through 8 and can be set in increments of 10s. The error interrupt vector automatically receives an address that is four locations higher than the A/D done interrupt vector whose recommended address is 000400 [see Figure 2-10(b)].
2.5 PROGRAMMING

2.5.1 Control/Status Register (CSR)
The significance of the CSR bits is defined below:

Bit 15: A/D ERROR (Read/Write) – The A/D ERROR may be program set or cleared and is cleared by the processor INITIALIZE. It is set by any of the following conditions:

1. Attempting an external or clock start during the transition interval (see Paragraph 2.3.2)
2. Attempting any start during a conversion in progress
3. Failing to read the result of a previous conversion before the end of the current conversion.

Bit 14: ERROR INTERRUPT ENABLE (Read/Write) – When set, enables a program interrupt upon an error condition (A/D ERROR). Interrupt is generated whenever bits 14 and 15 are set, regardless of which was set first.

Bits 13–12: Not used.

Bits 11–8: MULTIPLEXER ADDRESS (Read/Write) – Contain the number of the current analog input channel being addressed.

Bit 07: A/D DONE (Read) – Set at the completion of a conversion when the data buffer is updated. Cleared when the data buffer is read and by the processor INITIALIZE. If enabled interrupts are requested simultaneously by both bits 07 and 15, bit 07 has the higher priority.
Bit 06: DONE INTERRUPT ENABLE (Read/Write) – When set, enables a program interrupt at the completion of a conversion (A/D DONE). Interrupt is generated when bit 07 and bit 06 are both set, regardless of sequence.

Bit 05: CLOCK START ENABLE (Read/Write) – When set, enables conversions to be initiated by an overflow from the clock option.

Bit 04: EXTERNAL START ENABLE (Read/Write) – When set, enables conversions to be initiated by an external signal or through a Schmitt trigger from the clock option.

Bit 03: ID ENABLE (Read/Write) – When set, causes bit 12 of the Data Buffer Register to be loaded to a 1 at the end of any conversion.

Bit 02: MAINTENANCE (Read/Write) – Loads, when set, all bits of the converted data output equal to Multiplexer Address LSB (bit 08) at the completion of the next conversion. Cleared by the processor INITIALIZE. Used for “all 0s” and “all 1s” tests of A/D conversion logic.

Bit 01: Not used.

Bit 00: A/D START (Read/Write) – Initiates a conversion when set. Cleared at the completion of the conversion and by the processor INITIALIZE.

Figure 2-10  ADV11-A Address and Vector Switches (Rocker or Slide Switches)
2.5.2 Data Buffer Register (DBR)

The DBR is actually two separate registers – one read only, the other write only.

**Read Only (Cleared at processor initialize)**

*Bits 15–13:* Not used. Should read as 0.

*Bit 12:* ID (Read) – When ID ENABLE (bit 03) of the CSR has been set, DBR bit 12 will be loaded to a 1 at the end of conversion.

*Bits 11–00:* CONVERTED DATA (Read) – These bits contain the results of the last A/D conversion.

**Write Only (Set to 200<sub>x</sub> at processor initialize)**

*Bits 15–08:* Not used.

*Bits 07–00:* VERNIER D/A (Write) – These bits provide a programmed offset to the converted value (scaled: -1 D/A LSB = 1/50 A/D LSB). The hardware initializes this value to 200<sub>x</sub> (mid-range). Values greater than 200<sub>x</sub> make the input voltage appear more positive.
2.5.3 Programming Example
Read 100s A/D conversions from channel 0 into locations 4000s-4176s and halt.

| START: | CLR @ADSR | ; CLEAR A/D STATUS REGISTER |
|        | MOV @4000,RO | ; SET UP FIRST ADDRESS |
| LOOP:  | TST @ADSR | ; START A/D CONVERSION |
|        | BPL LOOP | ; CHECK DONE FLAG |
|        | INC @ADSR | ; WAIT UNTIL FLAG SET |
|        | MOV @ADBR,(R0)+ | ; START NEXT CONVERSION* |
|        | CMP R0,#4200 | ; PLACE CONVERTED VALUE |
|        | BNE LOOP | ; FROM A/D BUFFER INTO MEMORY |
|        | HALT | ; LOCATION AND SET UP NEXT |
|        | | ; LOCATION FOR TRANSFER* |
|        | | ; CHECK IF 100 CONVERSIONS |
|        | | ; HAVE BEEN DONE |
|        | | ; NO, GET NEXT CONVERSION |
| ADSR:  | 170400 | ; DONE |
| ADBR:  | 170402 | ; A/D STATUS REGISTER ADDRESS |
| END START | | ; A/D BUFFER REGISTER ADDRESS |

*Starting a subsequent conversion before moving data from a previous conversion is to be recommended only with systems equipped with non-processor memory refresh, as provided in the REV11 options. Without this capability, data will be lost occasionally by CPU memory refresh intervening between the INC and MOV commands. In general, non-processor memory refresh is essential to realizing the full potential of the ADV11-A.
CHAPTER 3  
KWV11-A PROGRAMMABLE REAL-TIME CLOCK

3.1 GENERAL DESCRIPTION  
The KWV11-A is a programmable clock/counter combination that provides a variety of means for determining time intervals or counting events. It can be used to generate interrupts to the LSI-11 processor at predetermined intervals, to synchronize the processor to external events, or to measure time intervals or establish programmed ratios between input and output events. It can also be used to start the ADV11-A Analog-to-Digital Converter either by clock counter overflow or by the firing of a Schmitt trigger.

The clock counter has a resolution of 16 bits and can be driven from any of five internal crystal-controlled frequencies (100 Hz to 1 MHz), from a line frequency input or from a Schmitt trigger fired by an external input. The KWV11-A can be operated in any of four programmable modes: single interval, repeated interval, external event timing, and external event timing from zero base.

The KWV11-A includes two Schmitt triggers, each with integral slope and level controls. The Schmitt triggers permit the user to start the clock, initiate A/D conversions, or generate program interrupts in response to external events.

The physical structure of the KWV11-A is illustrated in Figure 3-1. The unit is contained on one quad size module whose fingers interface to the LSI-11 Bus. User interfacing for the Schmitt triggers and clock overflow signals is accomplished by means of a multi-pin connector (J1). FAST ON connectors (CLK, ST1) are provided to permit direct and simple connections of clock overflow and Schmitt trigger outputs to corresponding terminals on the ADV11-A A/D Converter. Switch packs permit selecting CSR (Control/Status Register) address, interrupt vector address, and Schmitt trigger slope and level conditions. Screwdriver controls (R18 and R19) permit setting Schmitt trigger levels. Provision is also made via the multi-pin connector J1 for external user-provided slope switches and level controls.

3.2 SPECIFICATIONS (@ 25° C unless otherwise specified)

3.2.1 Clock

<table>
<thead>
<tr>
<th>Oscillator Accuracy</th>
<th>0.01%</th>
</tr>
</thead>
</table>

Range  
Base frequency (10 MHz) divided into five selectable rates (1 MHz, 100 kHz, 10 kHz, 1 kHz, 100 Hz); line frequency; Schmitt trigger 1 input

3.2.2 Input and Output Signals
All inputs and outputs are TTL compatible unless otherwise specified.
3.2.2.1 Input Signals

1. ST1 IN (Schmitt Trigger 1 Input)
   
   **Input Range**
   (maximum limits)

   -30 V to +30 V

   **Assertion Level**

   Depends upon position of slope reference selector switch and level control; triggering range, -12 V to +12 V

   **Origin**

   User device

   **Response Time**

   Depends upon input waveform and amplitude; typically 600 ns with TTL logic input

   **Hysteresis**

   Approximately 0.5 V, positive and negative

   **Characteristics**

   Single-ended input; 100 kΩ impedance to ground

2. ST2 IN (Schmitt Trigger 2 Input)

   Same description as ST1 IN

3-2
3.2.2.2 Output Signals

1. CLK OV (Clock Overflow)
   Asserted Level                    Low
   Destination                      User device or ADV11-A
   Duration                         Approximately 500 ns
   Characteristics                  TTL open-collector driver with 470 Ω pull-up to +5 V
   Maximum source current from output through load to ground when output is high (≥ 2.4 V): 5 mA
   Maximum sink current from external source voltage through load to output when output is low (≤0.8 V): 8 mA

2. ST1 Out (Schmitt Trigger 1 Output)
   Same description as CLK OV

3. ST2 OUT (Schmitt Trigger 2 Output)
   Same description as CLK OV

3.2.2.3 Environmental (ref: DEC STD 102, class C)

3.2.2.4 Power Requirements (from LSI-11 Bus Power Supply)

<table>
<thead>
<tr>
<th>Voltage</th>
<th>Current</th>
</tr>
</thead>
<tbody>
<tr>
<td>+5 V</td>
<td>1.75 A typical</td>
</tr>
<tr>
<td>+12 V</td>
<td>10 mA typical</td>
</tr>
</tbody>
</table>

3.3 FUNCTIONAL DESCRIPTION

3.3.1 Bus Control
Figure 3-2 illustrates the KWV11-A in block diagram form.

The logic associated with the bus control block maintains proper communications protocol between the processor bus and the KWV11-A. This logic generates and monitors the bus signals involved during interrupts and data transfers between the processor and the KWV11-A. It permits the KWV11-A to recognize when it is being addressed by the processor (address defined by the Address Switch Pack), to prescribe the location in memory pointing to the starting addresses of interrupt service routines (by means of the Vector Address Switch Pack), to input control data from the processor, and to output data to the processor.

Interrupts can be enabled for both counter overflow and operation of ST2. Since each of these conditions raises a flag bit in the Control/Status Register, and since separate interrupt vectors exist for each condition, the conditions may be distinguished either by vectors or by testing flag bits.

3.3.2 Control/Status Register
The Control/Status Register (CSR) provides a means for the processor to control the operation of the KWV11-A and to derive information about its operating condition. Bits are provided for enabling interrupts, mode selection, maintenance operations, starting the counter, and overflow and Schmitt trigger event monitoring. (See Figure 3-9 and Table 3-1.)
3.3.3 Mode Control
Logic circuitry associated with the mode control block permits KWV11-A operation in four different modes as specified by bits 2-1 of the CSR.

3.3.3.1 Mode 0 (Single Interval)
When the GO bit is set in this mode either by the processor or by a Schmitt Trigger 2 event, the counter is loaded from the Buffer/Preset Register (which has previously been loaded with the 2's complement of the number of counts desired before overflow). Once loaded, the counter will increment at the selected rate until it overflows. Overflow clears the GO bit, sets the Overflow Flag, and interrupts the processor if that function has been enabled. If interrupt has not been enabled, the KWV11-A waits for processor intervention.

3.3.3.2 Mode 1 (Repeated Interval)
When the GO bit is set in this mode, the counter is loaded from the Buffer/Preset Register (BPR) and is then incremented to overflow as for Mode 0. In Mode 1, however, overflow does not clear the GO bit; instead, it causes the counter to be reloaded from the BPR, raises the Overflow Flag, initiates an interrupt sequence if the CSR Interrupt on Overflow bit is set, and causes the count to be continued with no loss of data.
3.3.3.3 Mode 2 (External Event Timing)
When the GO bit is set in this mode, the counter is set to 0 and then incremented at the selected rate as long as the GO bit remains set. An external signal to Schmitt Trigger 2 (ST2) causes the current contents of the counter to be loaded into the BPR while the counter continues to run. At the same time the ST2 Flag is set and, if Interrupt 2 is enabled, an interrupt is generated, thus permitting the program to read the value held in the BPR.

The counter continues to run after the ST2 event and also continues to run after overflow. Interrupt on Overflow may be enabled to alert the program to the overflow condition.

3.3.3.4 Mode 3 (External Event Timing from Zero Base)
Operation in Mode 3 is identical to that in Mode 2 except that the counter is zeroed each time an ST2 event loads its contents into the BPR.

3.3.3.5 Flag Overrun
In all modes, if a second overflow occurs before the Overflow Flag is reset (i.e., before a prior event is serviced by the processor), or if ST 2 fires when the ST 2 flag is already set, the Flag Overrun bit is set.

3.3.4 Oscillator, Divider, Rate Control Chain
The circuitry associated with these blocks provides the time base that is fed to the counter. The KW11-A permits eight clock conditions to be specified by bits 5-3 of the CSR: STOP, 1 MHz, 100 kHz, 10 kHz, 1 kHz, 100 Hz, an external time base applied to ST1, and line frequency (50 or 60 Hz) picked up from bus line BEVNT. External periodic or aperiodic pulses may be applied to ST1 and counted, provided they meet the criteria in Paragraphs 3.2 and 3.3.6.

3.3.5 Buffer/Preset and Counter Registers
The Buffer/Preset Register is a word-oriented, 16-bit read/write register that can be loaded either under program control or from the counter. In Modes 2 and 3, the firing of ST2 causes the BPR to be loaded with the contents of the counter. The BPR cannot be loaded by the program in these modes as long as the GO bit is set.

The counter is a 16-bit internal register accessible only by way of the BPR; in Modes 2 and 3 it can be read indirectly through the BPR.

3.3.6 Schmitt Triggers
Both Schmitt triggers are equipped with switches to permit selecting slope direction (+ or -) and threshold reference level (TTL or -12V to +12V continuously variable). Each Schmitt trigger is also equipped with a screwdriver-operated potentiometer to permit setting the variable threshold level. Switch-pack and potentiometer terminals are all brought to multiple connector J1 to permit attachment of external user-provided slope and level controls. (See Figure 3-3.)

The two Schmitt triggers are used in somewhat different ways:

ST1 – Performs as an external time base input or external input for aperiodic signals to be counted. Outputs both to ST1 FAST ON connector to provide external start signals to ADV11-A and, through rate control circuitry, to permit selection as input to the counter. Maximum frequency varies as a function of input waveform.

ST2 – When the ST2 GO ENABLE bit is set, firing ST2 in any mode sets the GO bit and initiates counter action, causes the ST2 Flag to be asserted, and generates an interrupt if that function is enabled. When the GO bit is set in Modes 2 and 3, firing ST2 causes the Buffer/Preset Register to be loaded from the counter, the ST2 Flag to be set, and an interrupt to be generated if enabled.
3.4 CONNECTORS, SWITCHES, AND CONTROLS
Figure 3-1 illustrates the location of user connectors, switches, and controls on the component side of the KVV11-A board.

3.4.1 40-Pin Connector
Figure 3-4 illustrates the 40-pin connector pin assignments for user inputs and outputs. These pins may be connected to the optional H322 Distribution Panel* (see Paragraph 2.4.3.1) for convenient external user access. The proper Berg-to-Berg cable is the BC08R. The proper Berg to prepared open-ended cable is the BC04Z.

3.4.2 FAST ON Connectors (Clock Overflow and ST1 Outputs)
Two FAST ON connector tabs labeled CLK and ST1 are situated in the upper-right corner of the KVV11-A board (see Figure 3-1). These tabs are electrically in parallel with pins RR (CLK OV L) and UU (ST1 OUT L) on the 40-pin connector and are intended to facilitate connections by means of module jumpers (shown in Figure 2-9) to the clock overflow and external start inputs on the ADV11-A (see Paragraph 2.4.3).

3.4.3 Selector Switches (Address, Vector, and Slope/Reference Level)
Figure 3-1 identifies three switch packs (S1, S2, and S3) that the KVV11-A provides to facilitate the selection of CSR address, vector address, and slope/reference level conditions for Schmitt Triggers 1 and 2.

*The KVV11-A is shipped with decals which permit permanent identification of signal lines associated with H322 terminals.

Figure 3-3 Connecting External User-Supplied Slope and Level Controls
3.4.3.1 Address Selection – Switch Pack S1 contains 10 single-pole/single-throw switches that communicate with data lines BDAL 11–2. The KWV11-A reads the BDAL lines only in response to BBS7 which the processor asserts only for an address of 160000 or higher. For this reason, and because the KWV11-A transceivers are hard wired to respond only when BDAL bit 12 is set to 1, S1 permits assigning the CSR any address ending in 0 or 4 between 170000h and 177774h. The recommended address for the KWV11-A CSR is 170420, set as illustrated in Figure 3-5. The BPR automatically receives the next even address following that assigned to the CSR.

Figure 3-5  KWV11-A CSR Address Switches (Set for 170420)
3.4.3.2 Vector Selection – The clock overflow interrupt vector address is set by means of S3, a 7-switch pack of which only six switches are utilized. These switches communicate with BDAL lines 8–3 and can be set in increments of 104. The ST2 interrupt vector automatically receives an address that is four locations higher than the clock overflow interrupt vector whose recommended address is 0000440 (see Figure 3-6).

![Diagram of OCTAL EQUIVALENT and LOGICAL BIT VALUE]

Figure 3-6  KWV11-A Vector Address Switches (Set for 000440)

3.4.3.3 Slope and Reference Level Selector Switches and Controls (See Figure 3-7) – Slope and reference level selection for ST1 and ST2 are accomplished by means of S2, a 7-switch pack of which only switches 1–6 are used. Two reference modes are selectable for each Schmitt trigger – one that picks a fixed level appropriate to TTL logic, and one that picks a variable level that permits setting the ST threshold to any point between −12 and +12 V.

NOTE
User should take care that both TTL and variable switches for either Schmitt trigger are not on simultaneously. This condition will do no damage to components, but produces unpredictable reference levels. Note also that if no signal is connected to a Schmitt trigger input, both threshold switches for that ST should be open for noise immunity. Alternatively, ST1 IN and ST2 IN can be grounded externally.

Slope selection is accomplished by separate switches for ST1 and ST2, respectively. When the related switch is on, the firing point effectively occurs on the positive slope of the input waveform. When the switch is off, the firing point occurs on the negative slope. (See Figure 3-8.)

3.5 PROGRAMMING

3.5.1 CSR Bit Assignments
CSR bit assignments are identified in Figure 3-9 and defined in Table 3-1.
3.5.2 Buffer/Preset Register (BPR)
The BPR is a 16-bit, word-oriented, read/write register. Any attempt to write a byte into this register will result in a whole word being written. In Modes 0 and 1 the program may load it with the 2's complement of the number of counts desired before overflow. In Modes 2 and 3 it permits indirect reading of the clock counter.

3.5.3 Normal Control Sequences

3.5.3.1 Mode 0 (Single Interval) – Control code for operation in Mode 0 must support the following sequence:

1. Control program writes desired count (2's complement) into BPR (see Paragraph 3.3.5).
2. Program writes control code into Control/Status Register as indicated in Table 3-2.
3. If GO bit is set high, KWV11-A responds by loading the 16-bit counter (see Paragraph 3.3.5) from the BPR and enabling the counter; if GO bit is set low and ST2 GO ENABLE bit is set high, KWV11-A waits for ST2 event, then sets the GO bit and loads and enables the counter.
4. Counter increments until overflow, then halts (GO bit is cleared)
5. KWV11-A raises Overflow Flag and issues interrupt if the CSR INT OV bit is set; if interrupt is not enabled, KWV11-A waits for program intervention.
6. Program responds to interrupt or intervenes in consequence of other criteria (e.g., testing the Overflow Flag or the A/D Done Flag if overflow was used to start an A/D conversion). Program reads the CSR, clears the Overflow Flag, and if no counting or mode changes are required, sets the GO bit or the ST2 GO ENABLE bit to reenter the sequence at step 3.
NOTE:
ST is retriggered only after input waveform has moved beyond opposite threshold and then again passed selected threshold.

(a) SLOPE SELECTION: SLOPE switch ON (Positive Slope)

NOTE:
ST is retriggered only after input waveform has moved beyond opposite threshold and then again passed selected threshold.

(b) SLOPE SELECTION: SLOPE switch OFF (Negative Slope)

Figure 3-8  KWV11-A Slope Selection
<table>
<thead>
<tr>
<th>Bit</th>
<th>Set By/Cleared By</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>15 ST2 Flag</td>
<td>Set by the firing of Schmitt Trigger 2 or the setting of the MAINT ST2 bit in any mode while the GO bit or the ST2 GO ENABLE bit is set. Cleared under program control. Also cleared at the “1”-going transition of the GO bit unless the ST2 GO ENABLE bit has previously been set.</td>
<td>Must be cleared after servicing an ST2 interrupt to enable further interrupts. When cleared, any pending ST2 interrupt request will be cancelled. If enabled interrupts are requested at the same time by bits 07 and 15, bit 07 has the higher priority.</td>
</tr>
<tr>
<td>14 INT 2 (INTERRUPT ON ST2)</td>
<td>Set and cleared under program control.</td>
<td>When set, the assertion of ST2 Flag will cause an interrupt. If set while ST2 Flag is set, an interrupt is initiated. When cleared, any pending ST2 interrupt request will be cancelled.</td>
</tr>
<tr>
<td>13 ST2 GO ENABLE</td>
<td>Set and cleared under program control. Also cleared at the “1”-going transition of the GO bit.</td>
<td>When set, the assertion of ST2 Flag will set the GO bit and clear the ST2 GO ENABLE bit.</td>
</tr>
<tr>
<td>12 FOR (FLAG OVERRUN)</td>
<td>Set when an overflow occurs and the Overflow Flag is still set from a previous occurrence, or when ST2 fires and the ST2 Flag is already set. Cleared under program control and at the “1”-going transition of the GO bit.</td>
<td>This bit provides the programmer with an indication that the hardware is being asked to operate at a speed higher than is compatible with the software.</td>
</tr>
<tr>
<td>11 DIO (DISABLE INTERNAL OSCILLATOR)</td>
<td>Set and cleared under program control.</td>
<td>For maintenance purposes, this bit inhibits the internal crystal oscillator from incrementing the clock counter. Used in conjunction with bit 10 below.</td>
</tr>
<tr>
<td>10 MAINT OSC</td>
<td>Set under program control. Clearing is not required. Always read as a “0.”</td>
<td>For maintenance purposes, setting this bit high simulates one cycle of the internal 10 MHz crystal oscillator used to increment the clock counter.</td>
</tr>
<tr>
<td>9 MAINT ST2</td>
<td>Set under program control. Clearing is not required. Always read as a “0.”</td>
<td>Setting this bit simulates the firing of Schmitt Trigger 2. All functions initiated by ST2 can be exercised under program control by using this bit.</td>
</tr>
<tr>
<td>Bit</td>
<td>Set By/Cleared By</td>
<td>Remarks</td>
</tr>
<tr>
<td>--------------------------</td>
<td>----------------------------------------------------------------------------------</td>
<td>------------------------------------------------------------------------</td>
</tr>
<tr>
<td>8 MAINT ST1</td>
<td>Set under program control. Clearing is not required. Always read as a “0.”</td>
<td>Setting this bit simulates the firing of ST1. All functions initiated by ST1 can be exercised under program control by using this bit.</td>
</tr>
<tr>
<td>Write Only</td>
<td></td>
<td>If bit 6 is set, bit 7 set will initiate an interrupt. Bit 7 must be cleared after the interrupt has been serviced to enable further overflow interrupts. If cleared while an overflow interrupt request to the processor is pending, the request is cancelled. If enabled interrupts are requested at the same time by bits 07 and 15, bit 07 has the higher priority.</td>
</tr>
<tr>
<td>7 OVFLO FLAG</td>
<td>Set each time the counter overflows. Cleared under program control and at the “1”-going transition of the GO bit.</td>
<td></td>
</tr>
<tr>
<td>Read/Write to 0</td>
<td></td>
<td></td>
</tr>
<tr>
<td>6 INTOV</td>
<td>Set and cleared under program control.</td>
<td>When this bit is set, the assertion of OVFLO Flag will generate an interrupt. Interrupt is also generated if bit 6 is set while OVFLO Flag is set. If cleared while an overflow interrupt request to the processor is pending the request is cancelled.</td>
</tr>
<tr>
<td>(INTERRUPT ON OVERFLOW)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Read/Write</td>
<td></td>
<td></td>
</tr>
<tr>
<td>5:3 RATE</td>
<td>Set and cleared under program control.</td>
<td>These bits select clock counting rate or source.</td>
</tr>
<tr>
<td>Read/Write</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2:1 MODE</td>
<td>Set and cleared under program control.</td>
<td></td>
</tr>
<tr>
<td>Read/Write</td>
<td></td>
<td></td>
</tr>
<tr>
<td>0 GO</td>
<td>Set and cleared under program control. Also cleared when the counter overflows in Mode 0.</td>
<td>Setting this bit initiates counter action as determined by the rate and mode bits. In Modes 1, 2, and 3 it remains set until cleared. In Mode 0 it clears itself when counter overflow occurs. Clearing bit 0 zeroes and inhibits the counter.</td>
</tr>
</tbody>
</table>
3.5.3.2 **Mode 1 (Repeated Interval)** – Control code for operation in Mode 1 must support the following sequence:

1. Control program writes desired count (2’s complement) into the BPR.

2. Program writes control code into CSR as indicated in Table 3-3.

3. If GO bit is set high, KWV11-A responds by loading the 16-bit counter from the BPR and enabling the counter; if GO bit is set low and ST2 GO ENABLE bit is set high, KWV11-A waits for ST2 event, then sets the GO bit and loads and enables the counter.

4. Counter increments until overflow.

5. KWV11-A reloads counter from the BPR, reenables the counter, raises the Overflow Flag in the CSR, and issues interrupt to the processor if interrupt is enabled.

6. If second overflow occurs before first is serviced (i.e., if Overflow Flag is still high when next overflow occurs), KWV11-A Flag Overrun (FOR) bit in the CSR is set high to alert program that data has been lost.

7. Program responds to interrupt or intervenes in consequence of other criteria. Program reads CSR, clears the Overflow Flag, and if no counting or mode changes are required, sets the GO bit or the ST2 GO ENABLE bit to reenter the sequence at step 3.

3.5.3.3 **Mode 2 (External Event Timing)** – Control code for operation in Mode 2 must support the following sequence:

1. Program writes control code into CSR as indicated in Table 3-4.

2. KWV11-A responds by incrementing the counter (zeroed when the GO bit was cleared) at the selected rate until the GO bit is set to 0.

3. ST2 pulse loads current counter contents into BPR, sets the ST2 Flag, and generates interrupt if INT 2 is enabled.

4. Overflow sets OVFLO FLG high and, if INT OV bit is high, generates interrupt.

5. Counter continues to increment until processor sets GO bit to 0.

Normally, program enables INT 2 and/or INT OV bits, permitting the processor to synchronize its operations with the external ST2 events and prevent loss of data by reinitializing the process after step 4.
<table>
<thead>
<tr>
<th>Bit No.</th>
<th>CSR Name</th>
<th>Bit Condition as Written by Processor</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>15</td>
<td>ST2 FLG</td>
<td>0</td>
<td>Will be set to 1 on ST2 event. Cleared by leading edge of GO bit assertion except when ST2 GO ENA has previously been set.</td>
</tr>
<tr>
<td>14</td>
<td>INT 2</td>
<td>x</td>
<td>Set to 1 by program if interrupt on ST2 event is desired.</td>
</tr>
<tr>
<td>13</td>
<td>ST2 GO ENA</td>
<td>x</td>
<td>Set to 1 by program if GO is to be set by external signal to ST2. Cleared by leading edge of GO bit assertion.</td>
</tr>
<tr>
<td>12</td>
<td>FOR</td>
<td>(0)</td>
<td></td>
</tr>
<tr>
<td>11</td>
<td>DIO</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>10</td>
<td>MAINT OSC</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>9</td>
<td>MAINT ST2</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>8</td>
<td>MAINT ST1</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>7</td>
<td>OVFLO FLG</td>
<td>(0)</td>
<td>Will be set to 1 by counter overflow. Always cleared by leading edge of GO bit assertion.</td>
</tr>
<tr>
<td>6</td>
<td>INT OV</td>
<td>x</td>
<td>Set to 1 by program for interrupt on counter overflow.</td>
</tr>
<tr>
<td>5</td>
<td>RATE 2</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>RATE 1</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>3</td>
<td>RATE 0</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>MODE 1</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>1</td>
<td>MODE 0</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>GO</td>
<td>x</td>
<td></td>
</tr>
</tbody>
</table>

\(x = 0 \text{ or } 1, \text{ depending on user requirements.}\\(0) = \text{Automatically cleared by GO bit assertion.}\\
<table>
<thead>
<tr>
<th>Bit No.</th>
<th>CSR Name</th>
<th>Bit Condition as Written by Processor</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>15</td>
<td>ST2 FLG</td>
<td>0</td>
<td>Will be set to 1 on ST2 event. Cleared by leading edge of GO bit assertion except when ST2 GO ENA has previously been set.</td>
</tr>
<tr>
<td>14</td>
<td>INT 2</td>
<td>x</td>
<td>Set to 1 by program if interrupt on ST2 event is desired.</td>
</tr>
<tr>
<td>13</td>
<td>ST2 GO ENA</td>
<td>x</td>
<td>Set to 1 by program if GO is to be set by external signal to ST2. Cleared by leading edge of GO bit assertion.</td>
</tr>
<tr>
<td>12</td>
<td>FOR</td>
<td>(0)</td>
<td></td>
</tr>
<tr>
<td>11</td>
<td>DIO</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>10</td>
<td>MAINT OSC</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>9</td>
<td>MAINT ST2</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>8</td>
<td>MAINT ST1</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>7</td>
<td>OVFLO FLG</td>
<td>(0)</td>
<td>Will be set to 1 by counter overflow. Always cleared by leading edge of GO bit assertion.</td>
</tr>
<tr>
<td>6</td>
<td>INT OV</td>
<td>x</td>
<td>Set to 1 by program for interrupt on counter overflow.</td>
</tr>
<tr>
<td>5</td>
<td>RATE 2</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>RATE 1</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>3</td>
<td>RATE 0</td>
<td>x</td>
<td>See Table 3-1.</td>
</tr>
<tr>
<td>2</td>
<td>MODE 1</td>
<td>0</td>
<td>Set by program to 1.</td>
</tr>
<tr>
<td>1</td>
<td>MODE 0</td>
<td>1</td>
<td>Same as for Mode 0, except that bit is not cleared when counter overflows.</td>
</tr>
<tr>
<td>0</td>
<td>GO</td>
<td>x</td>
<td></td>
</tr>
</tbody>
</table>

x = 0 or 1, depending on user requirements.

(0) = Automatically cleared by GO bit assertion.
<table>
<thead>
<tr>
<th>Bit No.</th>
<th>CSR Name</th>
<th>Bit Condition as Written by Processor</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>15</td>
<td>ST2 FLG</td>
<td>0</td>
<td>Will be set to 1 on ST2 event. Cleared by leading edge of GO bit assertion except when ST2 GO ENA has previously been set.</td>
</tr>
<tr>
<td>14</td>
<td>INT 2</td>
<td>x</td>
<td>Set to 1 by program if interrupt on ST2 event is desired.</td>
</tr>
<tr>
<td>13</td>
<td>ST2 GO ENA</td>
<td>x</td>
<td>Set to 1 by program if GO is to be set by external signal to ST2. Cleared by leading edge of GO bit assertion.</td>
</tr>
<tr>
<td>12</td>
<td>FOR</td>
<td>(0)</td>
<td></td>
</tr>
<tr>
<td>11</td>
<td>DIO</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>10</td>
<td>MAINT OSC</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>9</td>
<td>MAINT ST2</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>8</td>
<td>MAINT ST1</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>7</td>
<td>OVFLO FLG</td>
<td>(0)</td>
<td>Will be set to 1 by counter overflow. Always cleared by leading edge of GO bit assertion.</td>
</tr>
<tr>
<td>6</td>
<td>INT OV</td>
<td>x</td>
<td>Set to 1 by program for interrupt on counter overflow.</td>
</tr>
<tr>
<td>5</td>
<td>RATE 2</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>RATE 1</td>
<td>x</td>
<td>See Table 3-1.</td>
</tr>
<tr>
<td>3</td>
<td>RATE 0</td>
<td>x</td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>MODE 1</td>
<td>1</td>
<td>Set by program to 2a.</td>
</tr>
<tr>
<td>1</td>
<td>MODE 0</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>GO</td>
<td>x</td>
<td>Set by program to 1 unless ST2 GO ENA is set; remains 1 until written to 0 by program. Cleared when counter overflows.</td>
</tr>
</tbody>
</table>

\(x = 0 \text{ or } 1\), depending on user requirements.
\((0) = \text{Automatically cleared by GO bit assertion.}\)
3.5.3.4 Mode 3 (External Event Timing from Zero Base) – Operation is identical to that in Mode 2 except that counter is zeroed after ST2 pulse. Counter continues to increment until GO bit is set to 0.

Note that the interval between two ST2 events may be measured directly in Mode 2 or 3 with processor assistance if the CSR ST2 GO ENABLE and Interrupt 2 bits are set before the first event and the GO bit is left clear. Under these conditions, the first ST2 event will set the GO bit (and thus start the counting process) and simultaneously issue an interrupt. If the interrupt service routine now clears the ST2 Flag bit, the next ST2 event will cause the BPR to be loaded from the counter in the normal Mode 2 fashion. The choice of Mode 2 or Mode 3 for such measurements will depend on whether or not an ongoing accumulation of time after the second event is required by the application. If such an accumulation is necessary, Mode 2 is appropriate since the counter is not zeroed after ST2 events.

3.5.4 Programming Example

Record point in double-precision timeframe for each ST2 event following GO. Program makes use of a 32-bit counter, the low order bits of which are taken directly from the KW111-A (KWBPR) and the high order bits of which are taken from a software counter (HINCT) that is incremented with each KWBPR overflow.

```
MIPS       MOV   #ST2SRV, @ST2VEC
            #0
            @ST2PSW, CLEAR PSW
            ADDR
            #200, @ST2PSW
            @ST2VEC, SET UP PSW FOR ST2
            INT., INTERRUPT (DISABLE
            ALL SUBSEQUENT
            INTERRUPTS)
            @OVSRV, LOAD OV VECTOR
            ADDR
            #200, @OVPSW
            @OVVEC, SET UP PSW FOR OV
            INT., INTERRUPT (DISABLE
            ALL SUBSEQUENT
            INTERRUPTS)

            MOV   #BUFFER, R0,
            BEGINNING OF
            BUFFER AREA
            #40115, @KCSR
            DEPOSIT 1MHZ, MODE 2,
            INT, OV EN, INT ST2 EN,
            AND GO INTO KWCN
            #FOR INTERRUPT
            #BY OVFL0 OR ST2
            #IS FOR BIT SET?
            #NO, CONTINUE
            #YES, SERVICE ST2
            #IF SET, SW OVERKICK CONDITION
            #IS ST2 FLAG SET?
            #NO, CONTINUE
            #YES, SERVICE ST2 FIRST
            #ACKNOWLEDGE ST2
            #OCCURRENCE
```

(example continued on next page)
INC HICNT
BEQ ENDSRV
BIC $200, @KWCSR
RTI

ST2SRV:
MOV HICNT, (R0)+
MOV @KWBP, R0+)
BIC $100000, @KWCSR
RTI

FORSRV:

ENDSRV:

KWCSR:
KWBP:
OVFVEC:
ST2VEC:
HICNT:
BUFFER:

170420
170422
440
444
0
*BLK= XXXX

;INCREASE MSB BY 1 COUNT
;BRANCH IF INCREASE CAUSES OVERFLOW
;ACKNOWLEDGE OV CLEAR OV BIT
;AND RETURN TO MAIN PROGRAM
;GET MSB FROM SOFT COUNT
;GET LSB FROM HARD COUNT
;ACKNOWLEDGE ST2
;AND RETURN TO MAIN PROGRAM
;EVENTS OCCURRING TOO FAST FOR CURRENT SERVICE
;32 BIT OVERFLOW OCCURRED
; XXXX=LENGTH OF RESULT BUFFER
CHAPTER 4
AAV11-A DIGITAL-TO-ANALOG CONVERTER

4.1 GENERAL DESCRIPTION
The AAV11-A is a 4-channel digital-to-analog converter module for use on the bus of the LSI-11 processor. The unit is made up of control and interfacing circuitry, four D/A converters, a dc-dc converter to provide power to the analog circuits, and a voltage reference. Each channel provides 12 bits of resolution. Each has its own holding register which can be separately addressed and can be written and read in either word or byte format. In addition, bits 0-3 of the fourth holding register are brought to the I/O connector for use as a 4-bit digital output register.

Jumpers permit manual selection of voltage range and operating mode (bipolar or unipolar).

4.2 SPECIFICATIONS (@ 25° C unless otherwise specified)

<table>
<thead>
<tr>
<th>Specification</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Number of D/A Converters</td>
<td>4</td>
</tr>
<tr>
<td>Digital Input</td>
<td>12 bits (binary encoded for unipolar mode, offset binary encoded for bipolar mode)</td>
</tr>
<tr>
<td>Digital Storage</td>
<td>Read-write, word or byte operable, single buffered</td>
</tr>
<tr>
<td>Analog Output Voltage Range (jumper selected)</td>
<td>±2.56 V, ±5.12 V, ±10.24 V bipolar; 0 V to +5.12 V, 0 V to +10.24 V unipolar</td>
</tr>
</tbody>
</table>
| Digital Output Characteristics (DAC 3 Holding Register Bits 3:0) | Source: 5.2 mA @ 2.4 V  
Sink: 16 mA @ 0.4 V |
| Resolution                                         | 1 part in 4096                                                       |
| Warm-Up Time                                       | 5 minutes minimum                                                   |
| Gain Accuracy                                      | Adjustable (factory-set for bipolar ±5.12 V; selection of other ranges may require recalibration) |
| Gain Temperature Coefficient                       | 10 ppm per degree C, maximum                                        |
| Offset Temperature Coefficient                      | 20 ppm of full scale range per degree C, maximum                    |
| Linearity                                           | ± 1/2 LSB maximum non-linearity                                    |
| Differential Linearity                             | ± 1/2 LSB, monotonic                                               |
| Output Impedance                                   | 1 Ω maximum at DAC output; 4 Ω maximum at end of BC08R 8 ft cable   |

4-1
Drive Capability
± 5 mA maximum per converter

Slewing Speed
5 V/μs

Rise and Settling Time
(4 μs; 8 μs with 5000 pF load in parallel with 1k Ω)

Rise and Settling Time (to 0.1% of final value)
4 μs; 8 μs with 5000 pF load in parallel with 1k Ω

Power Consumption
5 V ±5% @ 1.5 A, 12 V @ 0.4 A
(from LSI-11 bus power supply)

Environmental
Ref: DEC STD 102, class C

Packaging
One quad module

Bus Loading
1 bus load

4.3 FUNCTIONAL DESCRIPTION
Figure 4-1 illustrates the AAV11-A in block diagram form.

4.3.1 Bus Control
The logic associated with the bus control section maintains proper communications protocol between the processor LSI-11 bus and the AAV11-A. This logic generates and monitors the bus signals involved during data transfers between the processor and the AAV11-A, permitting the AAV11-A to recognize when it is being addressed by the processor (address defined by setting on the Address Switch Pack), to accept input data from the processor, and to output data to the processor.

4.3.2 Control Logic
The AAV11-A has no Control/Status Register. The four digital-to-analog converters continually generate voltages at their outputs that reflect whatever digital values have most recently been written into their respective holding registers. The role of the control logic is to make the necessary discriminations between requests to change the state of the holding registers (i.e., to write into the holding registers), and requests to put the holding register contents onto the BD lines where they can be picked up through the transceivers by the processor.

4.3.3 DACs 0, 1, and 2
Digital-to-analog conversion functions are performed in each of the four AAV11-A channels by identical circuits:

- A holding register which stores the digital value output by the processor
- A digital-to-analog converter (DAC) proper which generates a current that is a function of the holding register value and of the mode/level jumper conditions
- An amplifier that translates the current into a proportional voltage, provides a low output impedance for the channel, and permits adjustment of signal offset.

4.3.4 DAC 3
DAC 3 is identical to DACs 0, 1, and 2 except that Holding Register bits 0–3 are routed to the I/O connector as well as to the DAC. This arrangement permits these bits to be routed to external equipment that requires binary control signals at programmable intervals. Control data in these bit positions affects any 12-bit D/A conversion that they coincide with, but since they involve the least significant bits of the word, the worst-case error is less than 0.5%. Consequently, DAC 3 can be used as a 12-bit DAC or as an 8-bit DAC plus four output bits for CRT Intensify, Store, Non-Store, Erase, etc.

4-2
4.4 CONNECTORS, SWITCHES, AND CONTROLS

Figure 4-2 illustrates the location of user connectors, switches, and controls located on the component side of the AAV11-A board.

![Diagram of AAV11-A Connectors, Switches, and Controls]

Figure 4-2 AAV11-A Connectors, Switches, and Controls

4.4.1 40-Pin Connector

Figure 4-3 illustrates the 40-pin connector pin assignments for user outputs. These pins may be connected to the optional H322 Distribution Panel* (see Paragraph 2.4.3.1) for convenient external user access. The proper cable for this purpose is the BC08R. Also available is a Berg to prepared open-ended cable, the BC04Z.

Either a VR14 or VR17 CRT may be interfaced to the H322 via a user-created cable terminating in a 24-pin Amphenol, or equivalent, male plug (DEC #12-03466-00). A user-created cable may be connected to other types of CRT systems using a 25-pin connector such as a male DB25P type plug (DEC #12-05886-00).

*The AAV11-A is shipped with decals which permit permanent identification of signal lines associated with H322 terminals.
Figure 4-3  40-Pin Connector Pin Assignments

The BC04Z signal lines may be connected to user-selected pins on a male or female connector. A female 25 pin connector of the DB25S type (DEC #12-09326-00) may be used for general purposes. A male 25-pin connector of the DB25P type (DEC #12-05886-00) will interface several popular CRT systems to the AAV11. Either a VR14 or VR17 CRT may be interfaced by means of a 24-pin Amphenol, or equivalent, male plug (DEC #12-03466-00) to the BC04Z. Both the AAV11 and selected CRT must be set up and adjusted for electrical compatibility. The CRT manual should define appropriate connector pins for each AAV11 signal line. Appropriate software will be necessary to control a CRT.

4.4.2 Address Switches
Figure 4-2 identifies the location of S1, a switch pack containing 10 single-pole single-throw switches (1 unused) which, when set, transmit 0 logic levels to the compare inputs of the transceivers. Whenever the AAV11-A sees BBS7 transmit a logical 1 (indicating that the processor has placed an I/O device address on the bus), the transceivers compare the pattern created by the switches with that appearing on Bus Data/Address (BDAL) lines 3-11. If the patterns match, the processor is addressing the AAV11-A, and the latter prepares to load the DAC holding register identified by decoding bits 1 and 2 of the address word as defined in Figure 4-4.

Since the AAV11-A makes the comparison only in response to BBS7 (which the processor sets to 1 only in response to an address of 160000 or higher) when address line BD12 = 1, S1 permits assigning the four DACs any contiguous set of four even word addresses between 170000 and 177770. The recommended setting for S1 on the first AAV11-A is 170440, illustrated in Figure 4-5. Since LSI-11 bus address assignments for the AAV11-A extend from 170440 to 170476, up to four AAV11-A's can be accommodated on the same processor.

4-5
AAV11-A ADDRESS WORD

<table>
<thead>
<tr>
<th>15</th>
<th>14</th>
<th>13</th>
<th>12</th>
<th>11</th>
<th>10</th>
<th>09</th>
<th>08</th>
<th>07</th>
<th>06</th>
<th>05</th>
<th>04</th>
<th>03</th>
<th>02</th>
<th>01</th>
<th>00</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>n₂</td>
<td>n₁</td>
<td>n₀</td>
</tr>
</tbody>
</table>

n₀ = 0 : WORD OR LOW BYTE
n₀ = 1 : HIGH BYTE

n₂ n₁ DAC
0 0 0 0
0 1 1 1
1 0 2 2
1 1 3 3

<table>
<thead>
<tr>
<th>ADDRESS</th>
<th>DAC</th>
<th>MODE</th>
</tr>
</thead>
<tbody>
<tr>
<td>170440</td>
<td>0</td>
<td>WORD OR LOW BYTE</td>
</tr>
<tr>
<td>170441</td>
<td>0</td>
<td>HIGH BYTE</td>
</tr>
<tr>
<td>170442</td>
<td>1</td>
<td>WORD OR LOW BYTE</td>
</tr>
<tr>
<td>170443</td>
<td>1</td>
<td>HIGH BYTE</td>
</tr>
<tr>
<td>170444</td>
<td>2</td>
<td>WORD OR LOW BYTE</td>
</tr>
<tr>
<td>170445</td>
<td>2</td>
<td>HIGH BYTE</td>
</tr>
<tr>
<td>170446</td>
<td>3</td>
<td>WORD OR LOW BYTE</td>
</tr>
<tr>
<td>170447</td>
<td>3</td>
<td>HIGH BYTE</td>
</tr>
</tbody>
</table>

Figure 4-4  AAV11-A Address Decoding

4.4.3 Mode/Level Selector Jumpers
As shipped from the factory, the AAV11-A is set for bipolar operation between -5.12 and +5.12 V. Unipolar operation and operation with other voltage ranges can be achieved by proper changes in the mode/level jumpers (illustrated in Figure 4-2). See AAV11-A Installation and Service chapter for details.

4.5 INTERFACING TO OUTPUT DEVICES

4.5.1 Ground Connections
Analog output devices such as oscilloscopes may be either grounded or floating. If the oscilloscope is grounded, either through its power plug or through contact between its chassis and a grounded cabinet, the oscilloscope ground should not be connected to any of the AAV11-A ground pins. Doing so may result in a ground loop which will adversely affect scope control results as well as any ADV11-A operations. If the oscilloscope is floating, its ground should be connected to the AAV11-A logic ground, pins L, N, R, or T of the Berg connector. Note that the foregoing assumes that the computer power supply ground is connected to power line (earth) ground. If continuity checks reveal no such connection, attach a length of 12-gauge wire between the power supply ground and a convenient point associated with earth ground.
Oscilloscope X and Y inputs may be either differential or single-ended. Differential inputs should be driven as in Figure 4-6.

![Connection to Oscilloscope with Differential Input](image)

Figure 4-6  Connection to Oscilloscope with Differential Input

When oscilloscopes with single-ended inputs are involved, the AAV11-A analog grounds (pins UU and HH) are not used. Return path for X and Y signal currents is through ground for a grounded oscilloscope or through logic ground (pins L, N, R, or T) for a floating oscilloscope. Since the grounded, single-ended oscilloscope sees an input voltage which is the sum of the AAV11-A output and the ground difference voltage between the oscilloscope and the AAV11-A, noise and line frequency errors may be minimized by plugging the scope into an ac socket as close as possible to the computer. Running single-ended scopes in a floating configuration will eliminate noise and line frequency errors which are due to ground voltage differences.

4.5.2 Twisting
The effect of magnetic coupling into the scope input lines can be minimized for a differential-input scope by running the AAV11-A output and its return line in a twisted pair. No benefit is derived from a twisted pair with a single-ended scope input.

4.5.3 Shielding
The effect of electrostatic coupling into the scope input lines can be minimized by shielding the input lines from AAV11-A to the scope. The shield should be connected to ground at one end only. Grounding the shield at both ends may result in a ground loop which will adversely affect scope control results and any ADV11-A A/D operations.

4.5.4 Drive Capability
Careful selection of cabling is essential. The D/A outputs are capable of driving a maximum of 5000 pF. Output impedance is 1 ohm. Output current limit is 5 mA.

4.6 PROGRAMMING
All four DAC holding registers are automatically set to zero on system initialization. This produces -5.12 V at the DAC outputs when the mode/level jumpers are connected as delivered from the factory. Any holding register value remains in effect until changed by the processor in response to a program instruction. Coding to the D/A converters is offset binary for bipolar operation and straight binary for unipolar operation. Offset binary defines 0 as maximum negative voltage, mid-point (i.e., 4000, for the 12-bit AAV11-A) as 0 V, and all 1s (7777) as maximum positive voltage. These relationships are illustrated in Table 4-1.
<table>
<thead>
<tr>
<th>Input Code (octal)</th>
<th>Bipolar</th>
<th>Unipolar</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>±2.56 V</td>
<td>±5.12 V</td>
</tr>
<tr>
<td></td>
<td>(volts)</td>
<td>(volts)</td>
</tr>
<tr>
<td>0000</td>
<td>-2.56</td>
<td>-5.12</td>
</tr>
<tr>
<td>0001</td>
<td>-2.55875</td>
<td>-5.1175</td>
</tr>
<tr>
<td>3777</td>
<td>-0.00125</td>
<td>-0.0025</td>
</tr>
<tr>
<td>4000</td>
<td>0.0</td>
<td>0.0</td>
</tr>
<tr>
<td>4001</td>
<td>+0.00125</td>
<td>+0.0025</td>
</tr>
<tr>
<td>7777†</td>
<td>+2.55875</td>
<td>+5.1175</td>
</tr>
</tbody>
</table>

* Offset binary for bipolar, straight binary for unipolar operating modes. Conversions may be made between 2's complement signed binary and offset binary numbers by subtracting 4000\textsubscript{o} from the 2's complement number (or adding 4000\textsubscript{o} to the offset binary number) and using only the low order 12 bits of the result.

† Note that in all ranges, actual maximum positive voltage output is 1 LSB less than nominal maximum positive output.
CHAPTER 5
DRV11 PARALLEL LINE UNIT

5.1 GENERAL DESCRIPTION
The DRV11 is a general-purpose interface unit used for connecting parallel-line TTL or DTL devices to the LSI-11 bus over up to 25 feet of cable. It permits program-controlled data transfers at rates up to 44K words per second (with optimized programming) and provides LSI-11 bus interface and control logic for interrupt processing and vector generation. Data is handled by 16 diode-clamped input lines and 16 latched output lines. Device address is user-assigned and Control/Status Registers (CSR) and Data Registers are compatible with PDP-11 software routines.

Figure 5-1  DRV11 Parallel Line Unit

5.2 JUMPER-SELECTED ADDRESSING AND VECTORS

5.2.1 Locations
Jumpers for device address and vector selection are provided on the DRV11 as shown in Figure 5-2. Jumpers are installed at the factory for address 167770 (DRC5R) and vectors 300 (interrupt A) and 304 (interrupt B). These can be cut or removed by the user to program the module for his system application, as described in the following paragraphs.
5.2.2 Addressing
Jumpers involved with addressing include A3 through A12. Only address bits 03 through 12 are programmed by jumpers for DRV11 addressing, producing the 16-bit address word shown in Figure 5-3. The appropriate jumpers are removed to produce logical 1 bits; jumpers are installed to produce logical 0 bits.

5.2.3 Vectors
Jumpers involved with vector addressing include V3 through V7. Only vector bits 03 through 07 are programmed by the jumpers for DRV11 vector addressing, producing the 16-bit word shown in Figure 5-4. The appropriate jumpers are removed to produce logical 1 bits; jumpers are installed to produce logical 0 bits.

Figure 5-2 DRV11 Jumper Locations
5.3 INTERFACING TO THE USER'S DEVICE

5.3.1 General
Interfacing the DRV11 to the user's device is via the two board-mounted H854 40-pin male connectors. Pins are located as shown in Figure 5-5. Signal pin assignments for input interface J2 (connector no. 2) and output interface J1 (connector no. 1) are listed in Table 5-1. The proper Berg-to-Berg cable is a BC08R. The proper Berg to opened-cable is a BC04Z. Connection to the DRV11 can be made through the H322 Distribution Panel (see Figure 2-8). This unit is provided with decals, which when applied according to instructions on the decal sheet, identify the H322 screw terminals with respect to the associated pins on the DRV11 Berg connectors (A, B, UU, VV, etc.). Space is provided on the decal for specific user identification. Note that DRV11/H322 terminal relationships assumed by the decal sheet rest on connection of the BC08R cable so that stamped labels on female cable ends match embossed labels on male connectors – A/B to A/B, UU/VV to UU/VV. This normally means that any “this side up” labels face away from the board on which the male connector is mounted.

Each BC04Z cable from a DRV11 may be terminated in a female 25-pin connector such as a DB25S type (DEC #12-09326-00) socket. The user may assign the signal and ground lines from the BC04Z to specific connector pins. User apparatus may be connected into the socket by means of a male 25-pin connector such as a DB25P type plug (DEC #12-05886-00).

5.3.2 Output Data Interface
The output interface is the 16-bit buffer DROUTBUF. It can be either loaded or read under program control. When DROUTBUF is loaded by the CPU, the NEW DATA READY H 300 ns pulse is generated to inform the user's device of the data transfer. In order to allow data to settle on the interface cable, the trailing edge of this positive-going pulse should be used to strobe the data into the user's device. The system initialize signal (BINIT L) clears DROUTBUF. When an output line is set to logical 1, the TTL output is high (≥ 2.7 V); when an output is set to logical 0, the TTL output is low (≤ 0.5 V).
All output signals are TTL levels capable of driving five unit loads (8 mA sink\(^*\) @ 0.5 V, 400 \(\mu\)A source\(^**\) @ 2.7 V) except for the following:

NEW DATA READY = 10 unit loads

INIT (Initialize)* = 10 unit loads/connector

DATA TRANSMITTED = 30 unit loads

\(^*\)Common signal on both connectors.

\(^**\)Sink refers to current from external +5 V supply through load to output line when output is low.

\(^***\)Source refers to current from output line through load to ground when output is high.
Table 5-1 DRV11 Input and Output Signal Pins*

<table>
<thead>
<tr>
<th>Inputs</th>
<th>Outputs</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Signal</strong></td>
<td><strong>Connector</strong></td>
</tr>
<tr>
<td>IN00</td>
<td>J2</td>
</tr>
<tr>
<td>IN01</td>
<td>J2</td>
</tr>
<tr>
<td>IN02</td>
<td>J2</td>
</tr>
<tr>
<td>IN03</td>
<td>J2</td>
</tr>
<tr>
<td>IN04</td>
<td>J2</td>
</tr>
<tr>
<td>IN05</td>
<td>J2</td>
</tr>
<tr>
<td>IN06</td>
<td>J2</td>
</tr>
<tr>
<td>IN07</td>
<td>J2</td>
</tr>
<tr>
<td>IN08</td>
<td>J2</td>
</tr>
<tr>
<td>IN09</td>
<td>J2</td>
</tr>
<tr>
<td>IN10</td>
<td>J2</td>
</tr>
<tr>
<td>IN11</td>
<td>J2</td>
</tr>
<tr>
<td>IN12</td>
<td>J2</td>
</tr>
<tr>
<td>IN13</td>
<td>J2</td>
</tr>
<tr>
<td>IN14</td>
<td>J2</td>
</tr>
<tr>
<td>IN15</td>
<td>J2</td>
</tr>
<tr>
<td>REQ A</td>
<td>J1</td>
</tr>
<tr>
<td>REQ B</td>
<td>J2</td>
</tr>
<tr>
<td></td>
<td></td>
</tr>
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<td></td>
<td></td>
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<td></td>
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<tr>
<td></td>
<td></td>
</tr>
</tbody>
</table>

*Pulse signals, approximately 300-ns wide. Width can be changed by user.

5.3.3 Input Data Interface

The input interface is the 16-bit DRINBUF read-only register, comprising gated bus drivers that transfer data from the user's device onto the LSI-11 bus under program control. DRINBUF is not capable of storing data; hence the user must keep input data on the IN lines until read by the LSI-11 microprocessor. When it has read the data, the DRV11 generates a positive-going 300-ns DATA TRANSMITTED H pulse which informs the user's device that the data has been accepted. The trailing edge of the pulse indicates that the input transfer has been completed.

All input and request signals are one standard TTL unit load; inputs are protected by diode clamps to ground and +5 V. A +2.7 V to +5 V input is read as logical 1; 0 V to 0.5 V as logical 0.

5.3.4 Request Flags

Two signal lines (REQ A H and REQ B H) can be asserted by the user's device as flags in the DRCVR word. REQ B is available via connector no. 2 and can be read in DRCVR bit 15. REQ A is available via connector no. 1; it can be read in DRCVR bit 7. Two DRCVR interrupt enable bits, INT ENB A (bit 6) and INT ENB B (bit 5), allow automatic generation of an interrupt request when their respective REQ A or REQ B signals are asserted. Once the user's request signal has been asserted (logical 0 to logical 1 transition), it must remain asserted until the CPU completes interrupt processing. At this time, DATA TRANSMITTED or NEW DATA READY signals (see Paragraphs 5.3.2 and 5.3.3) can be used to cancel the request. Note that Request A has a higher priority than Request B, and that each of the interrupt enable bits can be set or reset under program control.

5.3.5 Initialization
The BINIT L processor-generated initialize signal is applied to DRV11 circuits for interface logic initialization. It is also available to the user's circuits via connectors J1 and J2 as follows:

<table>
<thead>
<tr>
<th>Connector/Pin</th>
<th>Signal</th>
</tr>
</thead>
<tbody>
<tr>
<td>J1/P</td>
<td>AINIT H</td>
</tr>
<tr>
<td>J2/RR</td>
<td>BINIT H</td>
</tr>
<tr>
<td>J2/NN</td>
<td>BINIT H</td>
</tr>
</tbody>
</table>

An active BINIT L signal will clear the following: DROUTBUF data; DRCR bits 6, 5, 1, 0; bits 16 and 7 (when the maintenance cable is connected); and Interrupt Request and Interrupt Acknowledge flip-flops.

5.3.6 NEW DATA READY and DATA TRANSMITTED Pulse Width Modification
An optional capacitor can be added by the user to the DRV11 module to extend the pulse width of both the NEW DATA READY and DATA TRANSMITTED pulses. The module without external capacitance (as shipped) will produce 300 ns pulses. The capacitor can be added in the location shown in Figure 5-2 to produce the approximate pulse widths listed below.

<table>
<thead>
<tr>
<th>Optional External Capacitance (pF)</th>
<th>Approximate Pulse Width (ns)</th>
</tr>
</thead>
<tbody>
<tr>
<td>None</td>
<td>300</td>
</tr>
<tr>
<td>1200</td>
<td>500</td>
</tr>
<tr>
<td>1800</td>
<td>600</td>
</tr>
<tr>
<td>6000</td>
<td>1200</td>
</tr>
</tbody>
</table>

5.4 PROGRAMMING

5.4.1 Addressing
Addresses for the DRV11 can range from 160000 through 17777X. The least significant three bits address the desired DRV11 register as follows:

<table>
<thead>
<tr>
<th>Address*</th>
<th>Device Register</th>
</tr>
</thead>
<tbody>
<tr>
<td>1XXXX0</td>
<td>DRCR</td>
</tr>
<tr>
<td>1XXXXX2</td>
<td>DROUTBUF</td>
</tr>
<tr>
<td>1XXXXX4</td>
<td>DRINBUF</td>
</tr>
</tbody>
</table>

Addresses 177560–177566 are reserved for the console device and should not be used for DRV11 addressing. The following address assignments are normally used:

First DRV11
DRCSR = 167770
DROUTBUF = 167772
DRINBUF = 167774

Second DRV11
167760 to 167764

Third DRV11
167750 to 167754

*Address 1XXXX6 will not produce a response from the DRV11.
Second DRV11
167760 to 167764

Third DRV11
167750 to 167754

5.4.2 Interrupt Vectors
Two interrupt vectors are jumper-selected in the range of 0 through 37X₄. The least significant three bits identify the interrupting function.

000xx0     Interrupt A
000xx4     Interrupt B

Vectors 60 and 64 are reserved for the console device and should not be used for DRV11 vectors.

5.4.3 Word Formats
The three word formats associated with the DRV11 are shown in Figure 5-6 and are described in Table 5-2.

5.4.4 I/O Timing
I/O transfers through the DRV11 occur as illustrated in Figure 5-7.

![Diagram of DRV11 Word Formats]

Figure 5-6  DRV11 Word Formats
<table>
<thead>
<tr>
<th>Word</th>
<th>Bit(s)</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>DRCR</td>
<td>15</td>
<td>REQUEST B — This bit is under control of the user's device and may be used to initiate an interrupt sequence or to generate a flag that may be tested by the program. When used as an interrupt request, it is asserted by the external device and initiates an interrupt provided the INT ENB B bit (bit 05) is also set. When used as a flag, this bit can be read by the program to monitor external device status. When the maintenance cable is used, the state of this bit is dependent on the state of CSR1 (bit 01). This permits checking interface operation by loading a 0 or 1 into CSR1 and then verifying that REQUEST B is the same value. Read-only bit. Cleared by INIT when in maintenance mode.</td>
</tr>
<tr>
<td></td>
<td>14-08</td>
<td>Not used. Read as 0.</td>
</tr>
<tr>
<td></td>
<td>07</td>
<td>REQUEST A — Performs the same function as REQUEST B (bit 15) except that an interrupt is generated only if INT ENB A (bit 06) is also set. When the maintenance cable is used, the state of REQUEST A is identical to that of CSR0 (bit 00). Read-only bit. Cleared by INIT when in maintenance mode.</td>
</tr>
<tr>
<td></td>
<td>06</td>
<td>INT ENB A — Interrupt enable bit. When set, allows an interrupt request to be generated, provided REQUEST A (bit 07) becomes set. Can be loaded or read by the program (read/write bit). Cleared by BINIT.</td>
</tr>
<tr>
<td></td>
<td>05</td>
<td>INT ENB B — Interrupt enable bit. When set, allows an interrupt sequence to be initiated, provided REQUEST B (bit 15) becomes set.</td>
</tr>
<tr>
<td></td>
<td>04-02</td>
<td>Not used. Read as 0. Can be loaded or read by the program (read/write bit). Cleared by INIT.</td>
</tr>
<tr>
<td>Word</td>
<td>Bit(s)</td>
<td>Function</td>
</tr>
<tr>
<td>----------</td>
<td>--------</td>
<td>------------------------------------------------------------------------------------------------------------------------------------------</td>
</tr>
<tr>
<td>DRCSR</td>
<td>01</td>
<td>CSR1 — This bit can be loaded or read (under program control) and can be used for a user-defined command to the device (appears only on Connector No. 1). When the maintenance cable is used, setting or clearing this bit causes an identical state in bit 15 (REQUEST B). This permits checking operation of bit 15 which cannot be loaded by the program. Can be loaded or read by the program (read/write bit). Cleared by INIT.</td>
</tr>
<tr>
<td></td>
<td>00</td>
<td>CSR0 — Performs the same functions as CSR1 (bit 01) but appears only on Connector No. 2. When the maintenance cable is used, the state of this bit controls the state of bit 07 (REQUEST A). Read/write bit. Cleared by INIT.</td>
</tr>
<tr>
<td>DROUTBUF</td>
<td>15-00</td>
<td>Output Data Buffer — Contains a full 16-bit word or one or two 8-bit bytes: High Byte = 15–8; Low Byte = 7–0. Loading is accomplished under a program-controlled DATO or DATOB bus cycle. It can be read under a program-controlled DATI cycle.</td>
</tr>
<tr>
<td>DRINBUF</td>
<td>15-00</td>
<td>Input Data Buffer — Contains a full 16-bit word or one or two 8-bit bytes. The entire 16-bit word is read under a program-controlled DATI bus cycle.</td>
</tr>
</tbody>
</table>
Figure 5-7  DRV11 Interface Signal Sequence
CHAPTER 6
ADV11-A, KWV11-A, and AAV11-A MAINTENANCE

6.1 MAINTENANCE PHILOSOPHY
Digital logic circuitry in the ADV11-A, KWV11-A, AAV11-A, and DRV11 is to be repaired in the normal manner. Analog circuitry, however, is to be repaired only at the factory. If any analog failures occur in the field, modules are to be board-swapped and returned to the factory for repair. Installations performed by DEC include installation of DEC-supplied equipment only. The customer is responsible for wiring from his equipment to the H322 Distribution Panel or to the end of the DEC-supplied cable.

6.2 ADV11-A ANALOG-TO-DIGITAL CONVERTER

6.2.1 Installation

6.2.1.1 Location – The ADV11-A is a single-module option which interfaces to an LSI-11 or PDP-11/03 through one of the quad locations in the LSI-11 backplane or in an expander box. Within the constraints imposed by the LSI-11 bus structure (refer to the LSI-11, Microcomputer Handbook – EB-06583 76 09/53) the unit may be mounted in any available location and will operate within specifications, regardless of proximity to the processor, memory, or other DEC options. Where circumstances permit, however, analog performance may be improved beyond specification levels by installing the unit away from the processor, memory modules, or other noise-producing options. Note that priority transfer requires that no empty unstrapped locations exist in the backplane between the processor and any device that communicates with it.

6.2.1.2 Address and Vector Selection – Select and set CSR and Vector addresses as indicated in Paragraph 2.4.3.4. Note that where more than one ADV11-A is involved, CSR addresses must be four locations apart (e.g., 170400, 170404, 170410, etc.). Vector addresses must be 10s locations apart (e.g., 000400, 000410, 000420, etc.). Remember to reinstall any covers removed from switch packs S1 and S2.

6.2.1.3 Board Insertion – Select a quad location, and making sure that the keyed edge connector matches the physical configuration of the terminal block, apply firm pressure alternately to the extractor handles near the opposite corners of the board until it is squarely and fully seated in the connector.

6.2.1.4 Test Connector – Do not insert I/O cables into the Berg connector at this point. Instead, insert the 7012894 test connector, which establishes the conditions required by the ADV11 Wraparound Test – that is, all channel inputs are grounded except 1, 2, 3, and 17, with internally-generated +4.5 V signal on channel 1, −4.5 V signal on channel 2, ramp signal on channel 3, and provision for external reference voltage on channel 17.

6.2.1.5 Shields – Install the 1700021-02 electromagnetic shields on both sides of the ADV11-A. Shields are insulated on both sides and physically separate the ADV11-A from adjacent modules but are not electrically connected to the system.
6.2.1.6 Acceptance – Conduct an acceptance test as specified in A-SP-ADV11A.

6.2.1.7 Final Connections

Cables
Remove the 7012894 test connector and install the BC08R cable (ADV11-A to H322 Distribution Panel) or the BC04Z cable (ADV11-A to user devices) in the ADV11-A Berg connector. Connect BC08R at both ends so that the stamped labels on the female cable ends match the embossed labels on the male connectors – A/B to A/B, UU/VV to UU/VV. This normally means that any “this side up” labels face away from the board on which the male connector is mounted.

NOTE
The BC08R cable is symmetrically wired but for several reasons is unsymmetrically labeled. That is, wires identified as A and B on one end are identified as UU and VV on the other end.

To simplify system relationships, the H322 PC board compensates for this inversion on the PC board that distributes Berg connector signals to front panel screw terminals. For this reason, the user can connect both ends of the BC08R according to the labels, A/B to A/B and UU/VV to UU/VV. So connected, signals from the ADV11-A will properly appear at front panel terminals which have been labeled according to the instructions on the ADV11-A decal sheet. Each BC04Z cable from an ADV11-A may be terminated in a female 25-pin connector such as a DB25S type (DEC 12-09326-00) socket. The user may assign the signal and ground lines from the BC04Z to specific connector pins. User apparatus may be connected to the socket by means of a male 25-pin connector such as a DB25P type plug (DEC 12-05886-00).

If KWV11-A is present, connect Faston terminals, as described in Paragraph 2.4.3.2.

Manual Voltage Control
Applications which require variable dc voltages to be applied to one or more channels of the ADV11-A can be implemented by the circuit illustrated in Figure 6-1. Note that the H323-B Potentiometer Box may not be used with the ADV11-A.

6.2.2 ADV11-A Circuity
The digital interface and control logic of the ADV11-A conforms in general to standard DEC practices and should be understandable to qualified technicians who have access to ADV11-A print sets and are familiar with overall ADV11-A functions as described in Chapter 2. Since the analog power supply and the A/D conversion sections involve some nonstandard circuits, they are discussed below.

6.2.2.1 ADV11-A Analog Power Supply

General
The ±15 V power for the analog circuits is derived from a dc-dc converter which consists of three basic sections: a 12 V power switch, positive and negative voltage doubler diode-capacitor banks, and a dual tracking voltage regulator. Output jumpers (W1 and W2) are provided to permit removing the load for troubleshooting purposes.
NOTE:
I. Value of R in kilohms can be calculated as follows:

\[ R = \frac{V_s - 6}{2.5 (N + 2)} \text{ KΩ} \]  \hspace{2cm} (1)

Where \( N \) = Number of channel pots.

Current drain from battery in milliamps when \( R \) is selected with equation (1) can be calculated as follows:

\[ I_{bat} = 2.5 (N + 2) \text{ mA} \] \hspace{2cm} (2)

Figure 6-1 Battery-Operated Potentiometer Box for ADV11-A A/D Converter

---

Figure 6-2 Analog Power Supply Block Diagram

**Power Switch**

Transistors Q15 and Q16 constitute the output stage of the 12 V power switch and provide a 0 V to +12 V switching signal, which is derived from the SW A and SW B signals, and which drives the voltage doubler diode-capacitor banks. Since saturated transistor switches turn on faster than they turn off, an idle is included (see Figure 6-3) to ensure that Q15 and Q16 are never on at the same time.

**Voltage Doubler**

The basic voltage doubler consists of a charge transfer stage (\( D_A \) and \( C_A \) in Figure 6-4) and a charge storage stage (\( D_B \) and \( C_B \) in Figure 6-3). When the power switch output is at 0 V, \( C_A \) charges to \( V_{\text{IN}} - V_{DA} \) (+11.3 V). When the power switch output goes to +12 V, \( D_A \) is reverse-biased and charge is transferred from \( C_A \) to \( C_B \). The power switch output then returns to 0 V, reverse-biasing \( D_B \) and recharging \( C_A - D_A \). The voltage on \( C_B \) builds up to approximately +12 V - \( V_{DA} \) +12 V - \( V_{DB} \).
The negative voltage doubler operates in a similar manner and consists of two basic doubler circuits in cascade with an additional input negative voltage generating stage (D26 and C47).

**Dual Voltage Regulator**

The dual voltage regulator comprises an LM325N (E50) tracking regulator and power boosters (Q17 and Q18). Output current limit sensing is provided by R60 and R61. This stage regulates the outputs from the doubler circuits to provide the ±15 V of analog power required by the various analog circuits.

**6.2.2.2 ADV11-A A/D Conversion Circuit** – The ADV11-A A/D converter circuit utilizes a patented auto-zeroing, successive approximation technique. The basic components of this circuit are illustrated in Figure 6-5.

**Analog Multiplexer**

The analog multiplexer consists of two 8-channel, single-ended multiplexer ICs (E47 and E48) whose outputs are connected together, thus forming a 16-channel multiplexer. During sample, when no conversion is in process, the addressed multiplexer channel is on. During hold, two conditions are possible. If single-ended (SE) mode is picked, all channels of the multiplexer are off and the auto-zero switch is on. If SE mode is not picked, the negative side of the selected quasi-differential pair is selected.
Auto-Zero
During sample, the feedback signal switch (Q5, Q6, Q8, Q9, Q10, and Q11) connects the output of the feedback preamplifier (Q2 – Q4) to the input of the sample-and-hold (Q13, E51, C67), thus completing the amplifier feedback path and allowing the sample-and-hold to track the analog input (see Figure 6-6).
Summing currents into the $\Sigma$ node:

$$I_D = \frac{E_1 + E_{OS1} - E_{OS2}}{R_D} + \frac{E_{SH} - E_{OS2}}{R_F} - I_V$$  

(1)

$E_{OS1}$ is the offset of the input buffer amplifier (E49) and $E_{OS2}$ is the offset of the feedback preamplifier.

When a conversion is initiated, the feedback signal switch disconnects the output of the feedback preamplifier from the input of the sample-and-hold, thus storing the signal, and connects the preamplifier output to the comparator (Q7 and Q12) input. Next, the A/D input, $E_1$, is either switched to the negative channel or is grounded through the auto-zero switch, E44, depending upon whether or not single-ended operation was selected.

At the completion of the conversion, the $\Sigma$ node is ideally equal to $E_{OS2}'$ (see Figure 6-7).

![Figure 6-7 A/D During Conversion](image)

Again summing currents into the $\Sigma$ node:

$$I_D' = \frac{E_1' + E_{OS1}' - E_{OS2}'}{R_D} + \frac{E_{SH}' - E_{OS2}'}{R_F} - I_V'$$  

(2)

Where $I_D'$ is the feedback D/A current at the completion of the LSB interrogation.

Subtracting equation (2) from equation (1):

$$I_D - I_D' = \frac{E_1 - E_1'}{R_D} - (I_V - I_V') + \frac{E_{OS1} - E_{OS1}'}{R_D} - \frac{E_{OS2} - E_{OS2}'}{R_F//R_D} + \frac{E_{SH} - E_{SH}'}{R_F}$$  

(3)

6-6
Note that since the offset due to the input buffer is the same in both cases,

$$E_{OS1} - E_{OS1}' = E_{OS1} - E_{OS1} = 0$$

$$R_D$$ $$R_D$$

$E_{OS2} - E_{OS2}'$ is controlled by R15 by forcing an offset shift in the feedback preamplifier and is used to null the offset caused by the sample-and-hold pedestal (ESH - ESH'). Note also that the conversion is not dependent upon the magnitude of $E_{OS2}$, but upon the forced shift. Therefore:

$$I_D - I_D' = \frac{E_1 - E_1'}{R_D} - (I_V - I_V')$$

If no vernier offset is programmed, $I_V = I_V'$,

and:

$$I_D - I_D' = \frac{E_1 - E_1'}{R_D}$$  \hspace{1cm} (4)

A/D Conversion

The 12-bit feedback D/A (E46) is initialized to 4000s.

$$I_D = \frac{1}{2} I_{FSR} - I_{LSB}$$ \hspace{1cm} (5)

During conversion, each bit of the feedback D/A is interrogated in sequence by the SAR (E39), starting with the MSB. At the end of each interrogation interval, the decision of the comparator to accept or reject that bit is clocked into the SAR where this decision is held. A positive voltage on the $\Sigma$ node will cause the comparator to reject a bit. Because of the overall negative feedback, this process will cause the $\Sigma$ node to work its way toward null (Figure 6-8). After the LSB interrogation, the contents of the SAR are transferred to the Data Buffer register.

![Diagram of A/D Conversion](image)

Figure 6-8  $\Sigma$ Node During Conversion

6-7
Since
\[ I_D' \min = 0 \text{ (@ code = 7777)} \]
and
\[ I_D' \max = I_{FSR} - I_{LSB} \text{ (@ code = 0000)}, \]
equations (4) and (5) permit voltage/current conversions to be derived as illustrated in Table 6-1.

<table>
<thead>
<tr>
<th>( I_D' )</th>
<th>Code</th>
<th>( I_D - I_D' )</th>
<th>( E_1 - E_1' )</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>7777</td>
<td>( 1/2 (I_{FSR} - I_{LSB}) )</td>
<td>( 1/2 (E_{FSR} - E_{LSB}) )</td>
</tr>
<tr>
<td>( 1/2 ) (( I_{FSR} ))</td>
<td>3777</td>
<td>-( I_{LSB} )</td>
<td>-( E_{LSB} )</td>
</tr>
<tr>
<td>( I_{FSR} - I_{LSB} )</td>
<td>0000</td>
<td>-( 1/2 ) (( I_{FSR} ))</td>
<td>-( 1/2 ) (( E_{FSR} ))</td>
</tr>
</tbody>
</table>

6.2.2.3 The Vernier DAC – The Vernier DAC is a digital-to-analog converter packaged in a single chip serving to provide programmable small increment offsets to the summing node of the A/D converter. It has been included in the ADV11-A circuit primarily to facilitate automatic testing of the module and is used by the diagnostic routines in the measurement of noise, offset error, and inter-channel settling error. The Vernier DAC is controlled through bits 07:00 of the Data Buffer register (write-only), accepting 8-bit offset binary code to produce positive and negative full scale offsets of 2.5 A/D LSBs.

6.2.3 ADV11-A Performance Test (MAINDEC-11-DVADA-A)
This diagnostic package permits complete testing of all functional aspects of the ADV11-A. It is divided into four major routines which are described below. Refer to diagnostic listing MAINDEC-11-DVADA-A for run instructions.

1. Wraparound Routine – consists of four subtests which can be run individually or consecutively:
   a. Analog Test – checks all channels and their outputs to ascertain whether or not multiplexing and gross conversion functions are working.
   b. Noise Test – determines whether or not the amount and distribution of short-term noise within the A/D converter is within limits.
   c. Interchannel Settling Test – Determines whether or not the A/D converter can recover from measurements at opposite extremes within specified times (switches alternately between channels 1 and 2 – i.e., between \(+4.5\ V\) and \(-4.5\ V\)).
   d. Differential Linearity and Relative Accuracy Test – makes multiple randomized measurements of ramp signal on channel 2 to determine, within 0.01 LSB, the width of the voltage band corresponding to each of the 4094 finite width states.

2. Calibration Routine – works interactively with operator to facilitate precise calibration of A/D. Requires precision voltage source.
Figure 6-9  ADV11-A Troubleshooting Procedure
3. Print Values routine – works interactively with operator to execute, and if desired, print out results of conversions on selected channels.

4. Logic Test Routine – consists of 23 subtests that run sequentially without operator intervention and check status register read/write operation, initialize conditions, A/D done flag setting and clearing, error flag setting, interrupt functions, etc.

6.2.4 Maintenance
In general, both routine maintenance and specific troubleshooting efforts will follow the flow defined in Figure 6-9. Preventive maintenance will consist of removing airborne dust accumulations, checking the power supply levels whenever new devices are added to the system, and running diagnostics whenever performance confirmation is desired.

6.2.5 Calibration (Requires Precision Voltage Source – EDC VS-11N or Equivalent)
With test connector installed in ADV11-A Berg socket, connect the floating reference voltage to the two clip-terminated leads (channel 17). Then, run the Calibration Routine and follow the step-by-step instructions it issues. The program will specify reference voltage settings and indicate when offset and gain potentiometers (identified in Figure 2-6) should be adjusted.

6.3 KWV11-A REAL TIME CLOCK

6.3.1 Installation

6.3.1.1 Location – The KWV11-A is a single-module option which interfaces to an LSI-11 through one of the quad locations in the LSI-11 backplane or in an expander box. Within the constraints imposed by the LSI-11 bus structure (refer to the Microcomputer Handbook – EB-06583 76 09/53), the unit may be mounted in any available location. Note that LSI-11 priority transfer requires that no empty unstrapped locations exist between the processor and the last device connected to the LSI-11 bus.

6.3.1.2 Address and Vector Selection – Select and set CSR and Vector Addresses as indicated in Paragraphs 3.4.3.1 and 3.4.3.2. Note that where more than one KWV11-A is connected to the same bus, CSR addresses must be four locations apart (e.g., 170420, 170424, 170430, etc.). Vector addresses for multiple KWV11-As must be 10 locations apart (e.g., 000440, 000450, 000460, etc.). Remember to reinstall any covers on switch packs S1 and S3.

6.3.1.3 Board Insertion – Select a quad location, and making sure that the KWV11-A board is oriented so that the keyed edge connector matches the physical configuration of the terminal block, apply firm pressure alternately to the extractor handles near the opposite corners of the board until it is squarely and fully seated in the connector.

6.3.1.4 Test Connections – Do not connect user equipment to Berg connector J1 at this time. Diagnostic I/O signal tests will require jumpers between specified pins on J1.

6.3.1.5 Acceptance – Conduct an acceptance test as specified in A-SP-KWV11-A-3.

6.3.2 Final Connections
Install FAST ON connectors between CLK/ST1 tabs and ADV11-A tabs as required. Install the BC08R cable (KWV11-A to H322 Distribution Panel) or BC04Z cable (KWV11-A to user devices) between the Berg connector (J1) and the appropriate terminus. Connect the BC08R at both ends so that the stamped labels on the female cable ends match the embossed labels on the male connectors – A/B to A/B, UU/VV to UU/VV. This normally means that any “this side up” labels face away from the board on which the male connector is mounted. (See Note in Paragraph 6.2.1.7.)
6.3.3 KWV11-A Circuitry
The digital logic of the KWV11-A conforms in general to standard DEC practices and should be understandable to qualified technicians who have access to KWV11-A print sets and are familiar with KWV11-A functions as described in Chapter 3.

6.3.4 KWV11-A Diagnostic (MAINDEC-11-DVKWA-A-D)
The KWV11-A diagnostic is divided into two main routines, the first designed to test logic functions on up to four KWV11-A modules, the second to test selected module I/O functions, ST1, ST2, and clock overflow. Refer to diagnostic listing MAINDEC-11-DVKWA-A-D for run instructions.

6.3.5 Maintenance
Preventive maintenance consists of removing airborne dust accumulations, checking that power supply levels remain within specifications whenever new devices are added to a system, and running diagnostics whenever performance confirmation is desired.

6.4 AAV11-A DIGITAL-TO-ANALOG CONVERTER

6.4.1 Installation

6.4.1.1 Location – The AAV11-A is a single-module option which interfaces to an LSI-11 or PDP-11/03 through one of the quad locations in the LSI-11 backplane or in an expander box. Within the constraints imposed by the LSI-11 bus structure (refer to the Microcomputer Handbook – EB-06583 76 09/53) the unit may be mounted in any available location and will operate within specifications, regardless of proximity to the processor, memory, or other DEC options. Where circumstances permit, however, analog performance may be improved beyond specification levels by installing the unit away from the processor, memory modules, or other noise-producing options. Note that priority transfer requires that no empty unstrapped locations exist in the backplane between the processor and any device that communicates with it.

6.4.1.2 Address Selection – Select and set address as indicated in Paragraph 4.4.2. Note that the least significant three bits of the address word are reserved for software addressing of the four digital-to-analog converters (DACs) and are therefore not selectable on the switch pack. For this reason, if several AAV11-As are installed on a system, they must be assigned addresses that are 10₈ locations apart.

6.4.1.3 Board Insertion – Select a quad location on the connector block, and making sure that the AAV11-A board is oriented so that the keyed edge connector matches the physical configuration of the connector block, apply firm pressure alternately to the extractor handles near the opposite corners of the board until it is squarely and fully seated in the connector block.

6.4.1.4 Test Connectors – If AAV11-A signals are to be routed to the H322 Distribution Panel, connection may be made to that unit at this time (see Paragraph 6.4.2). Otherwise, leave the Berg connector empty to allow for monitoring AAV11-A output signals in the next step.

6.4.1.5 Acceptance Test – Conduct an acceptance test as described in the AAV11-A Manufacturing and Field Acceptance Procedure (A-SP-AAV11-A-3).

6.4.2 Final Connections
Install the BC08R cable (AAV11-A to H322 Distribution Panel) or BC04Z cable (AAV11-A to user devices) between Berg connector (J1) and the appropriate terminus. Connect BC08R at both ends so that the stamped labels on the female connectors match the embossed labels on the male connectors – A/B to A/B, UU/VV to UU/VV. This normally means that any “this side up” labels face away from the board on which the male connector is mounted. (See Note in Paragraph 6.2.1.7.)
6.4.3 Mode/Level Selection
As shipped from the factory, the AAV11-A is set for bipolar operation between −5.12 V and +5.12 V. Unipolar operation and operation in other voltage ranges can be achieved by proper changes in mode/level jumpers (illustrated in Figure 4-2). Table 6-2 indicates jumper configurations for all bipolar voltage ranges; Table 6-3 indicates those for all unipolar ranges. Note that each of the four DACs on any given AAV11-A may be set for a different mode/level condition. Note also that any change from the factory settings may require recalibration of the DAC involved (see Paragraph 6.4.7).

<table>
<thead>
<tr>
<th>Table 6-2</th>
<th>Jumper Configurations for Bipolar Operation</th>
</tr>
</thead>
<tbody>
<tr>
<td>DAC 1</td>
<td>±2.56 V</td>
</tr>
<tr>
<td>W3</td>
<td>IN</td>
</tr>
<tr>
<td>W4</td>
<td>OUT</td>
</tr>
<tr>
<td>W5</td>
<td>IN</td>
</tr>
<tr>
<td>W6</td>
<td>IN</td>
</tr>
<tr>
<td>DAC 2</td>
<td>IN</td>
</tr>
<tr>
<td>W7</td>
<td>IN</td>
</tr>
<tr>
<td>W8</td>
<td>OUT</td>
</tr>
<tr>
<td>W9</td>
<td>IN</td>
</tr>
<tr>
<td>W10</td>
<td>IN</td>
</tr>
<tr>
<td>DAC 3</td>
<td>IN</td>
</tr>
<tr>
<td>W11</td>
<td>IN</td>
</tr>
<tr>
<td>W12</td>
<td>OUT</td>
</tr>
<tr>
<td>W13</td>
<td>IN</td>
</tr>
<tr>
<td>W14</td>
<td>IN</td>
</tr>
<tr>
<td>DAC 4</td>
<td>IN</td>
</tr>
<tr>
<td>W15</td>
<td>IN</td>
</tr>
<tr>
<td>W16</td>
<td>OUT</td>
</tr>
<tr>
<td>W17</td>
<td>IN</td>
</tr>
<tr>
<td>W18</td>
<td>IN</td>
</tr>
</tbody>
</table>

6.4.4 AAV11-A Circuity
The digital interface and control logic of the AAV11-A conforms in general to standard DEC practices and should be understandable to qualified technicians who have access to AAV11-A print sets and are familiar with overall AAV11-A functions as described in Chapter 4. The analog power supply and the digital-to-analog circuitry, however, make use of techniques and components with which DEC technicians may not be familiar. Since the analog power supply and the D/A conversion sections involve some non-standard circuits, they are discussed below.

6.4.4.1 AAV11-A Analog Power Supply
General (see Figure 6-1)
The ±15 V power for the analog circuits is derived from a dc-dc converter which consists of three basic sections: a 12 V power switch, positive and negative voltage doubler diode-capacitor banks, and a dual tracking voltage regulator.
Table 6-3 Jumper Configurations for Unipolar Operation

<table>
<thead>
<tr>
<th></th>
<th>$0 \text{ V} - +5.12 \text{ V}$</th>
<th>$0 \text{ V} - +10.24 \text{ V}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>DAC 1</td>
<td>IN</td>
<td>IN</td>
</tr>
<tr>
<td>W3</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W4</td>
<td>IN</td>
<td>OUT</td>
</tr>
<tr>
<td>W5</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W6</td>
<td></td>
<td></td>
</tr>
<tr>
<td>DAC 2</td>
<td>IN</td>
<td>IN</td>
</tr>
<tr>
<td>W7</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W8</td>
<td>IN</td>
<td>OUT</td>
</tr>
<tr>
<td>W9</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W10</td>
<td></td>
<td></td>
</tr>
<tr>
<td>DAC 3</td>
<td>IN</td>
<td>IN</td>
</tr>
<tr>
<td>W11</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W12</td>
<td>IN</td>
<td>OUT</td>
</tr>
<tr>
<td>W13</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W14</td>
<td></td>
<td></td>
</tr>
<tr>
<td>DAC 4</td>
<td>IN</td>
<td>IN</td>
</tr>
<tr>
<td>W15</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W16</td>
<td>IN</td>
<td>OUT</td>
</tr>
<tr>
<td>W17</td>
<td>OUT</td>
<td>OUT</td>
</tr>
<tr>
<td>W18</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Table 6-4 AAV11-A Input Code/Output Voltage Relationships

<table>
<thead>
<tr>
<th>Input Code</th>
<th>Unipolar</th>
<th>Bipolar</th>
</tr>
</thead>
<tbody>
<tr>
<td>0000</td>
<td>0 V</td>
<td>-FS</td>
</tr>
<tr>
<td>4000</td>
<td>1/2 FS</td>
<td>0 V</td>
</tr>
<tr>
<td>7777</td>
<td>+FS - 1/2 LSB</td>
<td>+FS - 1/2 LSB</td>
</tr>
</tbody>
</table>

**Power Switch**

Transistors Q2 and Q3 constitute the output stage of the 12 V power switch and provide a 0 V to +12 V switching signal, which is derived from the SW A and SW B signals, and which drives the voltage doubler diode-capacitor banks. Since saturated transistor switches turn on faster than they turn off, an idle time is included (see Figure 6-2) to ensure that Q2 and Q3 are never on at the same time.

**Voltage Doubler**

The basic voltage doubler consists of a charge transfer stage ($D_A$ and $C_A$ in Figure 6-3) and a charge storage stage ($D_B$ and $C_B$ in Figure 6-3). When the power switch output is at 0 V, $C_A$ charges to $V_{IN} - V_{DA} (+11.3 \text{ V})$ through $D_A$. When the power switch output goes to +12 V, $D_A$ is reverse-biased and charge is transferred from $C_A$ to $C_B$ through $D_B$. The power switch output then returns to 0 V, reverse-biasing $D_B$ and recharging $C_A$ through $D_A$. The voltage on $C_B$ builds up to approximately $+12 \text{ V} - V_{DA} + 12 \text{ V} - V_{DB} (+22 \text{ V})$. 

6-13
The negative voltage doubler operates in a similar manner and consists of two basic doubler circuits in cascade with an additional input negative voltage generating stage (D21/22 and C42/43).

**Dual Voltage Regulator**

The dual voltage regulator comprises an LM325N (E38) tracking regulator and power boosters (Q4 and Q5). Output current-limit sensing is provided by R57 and R58. This stage regulates the outputs from the doubler circuits to provide the ±15V of analog power required by the various analog circuits.

6.4.4.2 Digital-to-Analog Circuits – The analog sections of the AAV11-A consist of four 12-bit D/A converters (each contained on one 24-pin chip), four 2505 operational amplifiers, and a +10 V precision reference source.

Each D/A converter (DAC) contains the necessary circuits to generate a 0–2 mA output current and to modify that current as a function of the 12 input data bits. A 1-LSB change in the data register corresponds to a change of 1 part in 4096 of the full scale output, approximately 1/2 μA.

The output of the DAC is fed into a 2505 operational amplifier which converts the drive current into a voltage output. The feedback from the output of the amplifier is passed through the selected feedback resistors. The interconnections between these resistors, determined by the mode/range straps illustrated in Figure 4-2, determine the operating mode (unipolar or bipolar) and voltage range of the DAC in question.

Gain and offset of each DAC are controlled through the externally-adjustable potentiometers (see Figure 4-2).

6.4.5 AAV11-A Diagnostic Test (MAINDEC-11-DVAAA-A)

The AAV11-A Diagnostic Test is divided into four routines. Each is briefly described below.

1. Logic Tests (starting address: 200) – exercises and monitors behavior of interface and control logic of all DACs on all AAV11-As in a system. Checks that DAC holding registers can be loaded, cleared, and modified without error.

2. Ramp Loop (starting address: 204) – reiteratively increments the holding register for each DAC to produce full-scale ramp voltages successively at the output of each DAC. Permits confirmation by oscilloscope of DAC linearity, settling time, and channel isolation.

3. Static Calibration Loop (starting address: 210) – permits operator to input control data to all DACs and monitor resulting output conditions. Run with a precision DVM as output monitor, the Static Calibration Loop permits calibration of gain and offset of each DAC.

4. Dynamic Calibration Loop (starting address: 214) – reiteratively switches each DAC between maximum and minimum output conditions. Facilitates checking DAC response and recovery characteristics as well as amplifier slew rates.

6.4.6 Maintenance

In general, both routine maintenance and specific troubleshooting efforts will follow the flow defined in Figure 6-10. Since the diagnostic program has no way of evaluating AAV11-A analog performance, pass or failure of all but the logic tests depends on the judgment of the operator. Refer to the AAV11-A Manufacturing and Field Acceptance Procedure (A-SP-AAV11-A-3) for applicable criteria.

Preventive maintenance consists of removing airborne dust accumulations, checking that power supply levels remain within specifications whenever new devices are added to a system, and running diagnostics whenever performance confirmation is desired.
Figure 6-10  AAV11-A Troubleshooting Procedure
6.4.7 Calibration
Prepare the system to permit access to signal line(s) and calibration potentiometers of DAC(s) to be calibrated. Connect DVM of appropriate precision (note that 1 LSB on ±2.56 V bipolar or 0–5.12 V unipolar = 1.25 mV) to output of DAC to be measured. Float the DVM as illustrated in Figure 6-11. Take care to connect DVM common lead to HQ ground associated with the DAC in question. Then proceed as follows:

1. Load DAC holding register with 0000.
2. Adjust offset potentiometer (see Figure 4-2) for DVM reading appropriate to selected mode/level condition (see Table 4-1).
3. Load DAC holding register with 7777.
4. Adjust gain potentiometer for DVM reading appropriate to selected mode/level condition (see Table 4-1).
5. Load DAC holding register with 4000.
6. Check DVM for reading appropriate to selected mode/level condition (see Table 4-1).

Step 6 should produce a reading accurate to 1-1/2 LSB.

Figure 6-11 Floating the DVM

6.5 DRV11 PARALLEL LINE INTERFACE
Refer to the Microcomputer Handbook (EB-06583 76 09/53).
GLOSSARY OF A/D TERMS

Absolute Accuracy
The analog error, expressed as a percentage of full scale, referenced to the National Bureau of Standards volt.

Acquisition Time
The time duration between the giving of the sample command and the point when the output remains within a specified error band around the input value.

Aperture Delay Time
The time elapsed between the hold command and the point at which the sampling switch is completely open.

Aperture Uncertainty
The variation in aperture delay time for a particular sample-and-hold.

Common Mode Rejection (CMR)
The ability of a differential amplifier to reject noise common to both inputs. Common mode rejection is expressed as a ratio, the Common Mode Rejection Ratio (CMRR). A differential amplifier with a CMRR of 80 dB (10,000:1) would have an output voltage of 0.5 mV if both inputs were 5 V (5 V/80 dB).

Crosstalk
The amount of signal coupled to the output as a percentage of input signal applied to all off channels.

Differential Inputs (True)
Two external signals applied to the input circuitry of an A/D system whereby the first is subtracted from the second. The difference is applied to the A/D system. This is generally used with twisted pair wiring to reduce noise pickup.

Example
\[ V_0 = (V+) - (V-) \]
\[ = [V_1 + V_{(1)} \text{ noise}] - [V_2 + V_{(2)} \text{ noise}] \]
\[ = [V_1 - V_2] + [V_{(1)} \text{ noise} - V_{(2)} \text{ noise}] \]

For twisted pair wiring:
\[ V_{(1)} \text{ noise} = V_{(2)} \text{ noise} \]
\[ \therefore V_0 = V_1 - V_2 \]
Differential Inputs (Psuedo)
This method of inputting is similar to true differential inputting except that the negative input to the A/D system is common to the other inputs.

Differential Linearity
The maximum deviation of an actual stated width from its theoretical value for any code over the full range of the converter. A differential linearity of ±1/2 LSB means that the width of each code over the range of the converter is 1 LSB ±1/2 LSB. Missing codes in an A/D converter occur when the output code skips a digit. This happens when the differential linearity is worse than ±1 LSB.

Drift
Drift is a function of the temperature coefficients of the components. It is the major contributor to gain and offset error.

Gain Error
The error, expressed as a percentage, by which the actual full scale range differs from the theoretical full scale range. This error is adjustable to zero.

Gain Temperature Coefficient
This is the amount of gain that changes with a change in temperature. This may be expressed in ppm/°C or °C/LSB at full scale. If an A/D has a gain temperature coefficient of 20° C/LSB at F.S., the A/D converted value will be off by 1 LSB at full scale if the temperature rises 20° C above 25° C.

Input Bias Current
The amount of current that flows into the selected A/D channel from the source.

Input Impedance (dc)
The resistance seen at the input to an A/D system.

Linearity
Linearity is defined as the maximum deviation from a straight line drawn between the end points of the converter transfer function. Linearity may be expressed as a percentage of full scale or as a fraction of an LSB.

Multiplexer
The multiplexer is a set of switches that permits analog data from different sources (channels) to be supplied to the sample-and-hold (or A/D converter) individually.

Multiplexer Settling Time
The maximum time required to reach a specified error band around the input value when switching channels.

Offset Error
The error by which the transfer function fails to pass through the origin. This is usually adjustable to zero.

Quantization Error
Quantization error is defined as the basic uncertainty associated with digitizing an analog signal, due to the finite resolution of an A/D converter. An ideal converter has a maximum quantization error of ±1/2 LSB.

Quasi-Differential
Like true differential operation (see Differential Inputs) in that measurement is made of the difference between an input and a return line. Unlike true differential, however, in that measurement is not made at one instant in time, but rather throughout the variation of the conversion.

Relative Accuracy
This is defined as the input to output error as a fraction of full scale with gain and offset errors adjusted to zero. Relative accuracy is dependent on linearity.
Resolution
The resolution of an A/D converter is defined as the smallest analog change that can be distinguished. Resolution is the analog value of the least significant bit.

\[
\text{Resolution} = \frac{\text{Full scale}}{\text{Least significant bit}}
\]

For example, if a system requires a weight measurement range of 2540 lb, measured to the nearest 3 lb,

\[
\text{Resolution} = \frac{2540}{3} = 847 \text{ code combinations}
\]

The closest standard A/D converter resolution available is 10-bits binary. A binary resolution of 10-bits selected. The new resolution for this channel is recalculated for 10 bits.

\[
1 \text{ LSB (least significant bit)} = \frac{\text{Full scale range}}{2^n} = \frac{2540}{1024} = 2.5 \text{ lb}
\]

Sample-and-Hold
In order to ensure that input voltage does not change during a conversion, a sample-and-hold is required. If the change during a conversion cycle is less than 1/2 LSB, then a sample-and-hold circuit is not required.

Example
Conversion Speed = 20 \(\mu\)s
Full Scale Input Range (FSR), where \(\omega_{\text{max}} = 2 \pi \text{ (BW)}\)
Converter Resolution = 10 bits
LSB Value = .01 V/bit
1/2 LSB = 0.005 V

Maximum slew = 0.005 V/20 \(\mu\)sec = 250 \(\mu\)V/\(\mu\)sec = 250 V/sec
(Rate required for no sample-and-hold)

\[e_{\text{in}} = \frac{1}{2} \text{(FSR)} \sin \omega t\]
then \(\frac{de}{dt} = (1/2)\omega \text{(FSR)} \cos \omega t\)
\[\therefore \frac{\text{de}}{dt} \mid_{\text{max}} = (1/2)\omega_{\text{max}} \text{(FSR)} = \pi \text{ (BW)} \text{(FSR)}, \text{ where } \omega_{\text{max}} = 2 \pi \text{ (BW)}\]
or 250 V/sec = \pi \text{ (BW)} \text{(FSR)}

\[\text{BW} = 250 \text{ V/sec} / \pi (10.24 \text{ V}) \approx 7.77 \text{ Hz}\]

Slew Rate
The capability of the output of an analog circuit to change its voltage in a given period of time. If the slew rate is 7 \(V/\mu\)sec, the analog circuit output will change seven volts in one \(\mu\)sec.

GLOSSARY-3
Successive Approximation

A method that is used to transform the analog signal to a digital number.

An analog signal is compared to a logic generated signal. The logic always supplies a half range signal initially. For example, the full scale input to an A/D converter system is 10 V and the input to the system is 7 V.

<table>
<thead>
<tr>
<th>Try*</th>
<th>New Logic Voltage</th>
<th>Is the Input Greater Than New Voltage</th>
<th>A/D Buffer Bits</th>
<th>Decision</th>
<th>A/D Register Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>5 V</td>
<td>5 V</td>
<td>Yes</td>
<td>6</td>
<td>Add +5 = +5</td>
<td>1000000</td>
</tr>
<tr>
<td>2.5 V</td>
<td>5 + 2.5 V</td>
<td>No</td>
<td>5</td>
<td>Do nothing</td>
<td>1000000</td>
</tr>
<tr>
<td>1.25 V</td>
<td>5 + 1.25 V</td>
<td>Yes</td>
<td>4</td>
<td>Add 1.25 - 6.25</td>
<td>1010000</td>
</tr>
<tr>
<td>.625 V</td>
<td>6.25 + .625 V</td>
<td>Yes</td>
<td>3</td>
<td>Add .625 - 6.875</td>
<td>1011000</td>
</tr>
<tr>
<td>.3125 V</td>
<td>6.875 + .3125 V</td>
<td>No</td>
<td>2</td>
<td>Do nothing</td>
<td>1011000</td>
</tr>
<tr>
<td>.15625 V</td>
<td>6.875 + .1562 V</td>
<td>No</td>
<td>1</td>
<td>Do nothing</td>
<td>1011000</td>
</tr>
<tr>
<td>.078125 V</td>
<td>6.875 + .078125 V</td>
<td>Yes</td>
<td>0</td>
<td>Add .078175</td>
<td>1011001</td>
</tr>
</tbody>
</table>

*This is a 7-bit A/D
1011001 = 7 V in 10 V full scale range.
**Throughput Speed**

The Nyquist sampling theorem states that a minimum of two samples per cycle are required to completely recover continuous signals in a noiseless environment. In typical instrumentation systems noise does exist and from 5–10 samples per cycle are required.

For applications with dc and very low frequency signals, sample rate is usually a sub-multiple of the powerline frequency to provide essentially infinite rejection of these frequencies.

The minimum sampling speed required is the number of samples per cycle multiplied by the highest frequency component of the data. For time multiplexed systems, the speed requirement of the A/D converter is dependent on system throughput speed. System conversion speed is determined from data bandwidth, the number of channels, and the sampling factor by:

\[
\text{System throughput} = (N) (n) \ (\text{B.W.}) \text{ samples/second}
\]

\[
n = \text{number of channels}
\]

where \( N \) = number of samples/cycle (sampling factor)

\( \text{B.W.} \) = largest bandwidth of any channel

**Example**

- Channel 1 bandwidth 100 Hz
- Channel 2 bandwidth 200 Hz
- Channel 3 bandwidth 250 Hz

\[
\text{throughput} = 10 \times 3 \times (250) = 7500 \text{ sample/second}
\]

\[
N = 10
\]

\[
n = 3
\]

\[
\text{BW} = 250 \text{ Hz}
\]

The A/D throughput is comprised of the following:

- Multiplexer settling time
- Sample & Hold settling time
- A/D conversion speed
- A/D recovery time
- Computer acquisition time (Software)
Your comments and suggestions will help us in our continuous effort to improve the quality and usefulness of our publications.

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What features are most useful?

What faults do you find with the manual?

Does this manual satisfy the need you think it was intended to satisfy?

Does it satisfy your needs? Why?

Would you please indicate any factual errors you have found.

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Street Department
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Errata Sheet

Please make the following changes to the User's Manual (document no. EK-ADV11-OP-002).

pg vi Under ILLUSTRATIONS, add after Figure 2-8:

Figure 2-8a  H3220 Distribution Panel

(See Figure 2-8a below.)

pg 2-11 Paragraph 2.4.3.1 should read:

Figure 2-8 shows an H322 Distribution Panel that is connected on the rear to the ADV11-A Berg connector and provides easily identifiable and concurrently accessible screw terminals for user apparatus on the front. Figure 2-8a shows an H3220 Distribution Panel, which can be used for the same purpose. Each H322 or H3220 accommodates two ADV11-As or one ADV11-A and one other single-connector device. The ADV11-A is shipped with a decal set (appropriate for the H3220 distribution panel) that specifically identifies ADV11-A inputs and outputs. Note that the H323-B Potentiometer Box may not be used with the ADV11-A. (See Maintenance chapter for appropriate potentiometer box circuit.)

pg 2-13 Add Figure 2-8a.

Figure 2-8a  H3220 Distribution Panel
Paragraph 3.4.1, second sentence should read:

These pins may be connected to the optional H322 or H3220 Distribution Panel* (see Paragraph 2.4.3.1) for convenient external user access.

The footnote at the bottom of the page should read:

*The KVV11-A is shipped with decals that permit permanent identification of signal lines associated with H3220 terminals.

Paragraph 4.4.1, second sentence should read:

These pins may be connected to the optional H322 or H3320 Distribution Panel* (see Paragraph 2.4.3.1) for convenient external user access.

The footnote at the bottom of the page should read:

*The AAV11-A is shipped with decals that permit permanent identification of signal lines associated with H3220 terminals.

Paragraph 5.3.1, sixth and seventh sentence should read:

Connection to the DRV11 can be made through the H322 or H3220 Distribution Panel (see Figures 2-8 and 2-8a). This unit is provided with decals, which, when applied to the H3220 Distribution Panel, identify the H3220 screw terminals with respect to the associated pins of the DRV11 Berg connectors (A, B, UU, VV, etc.)

Ninth sentence should read:

Note that DRV11/H322 and DRV11/H3220 terminal relationships assumed by the decal sheet rest on connection of the BC08R cable so that stamped labels on female cable ends match embossed labels on male connectors A/B to A/B, UU/VV to UU/VV.

Paragraph 6.1, last sentence should read:

The customer is responsible for the wiring from his/her equipment to the H322 and/or H3220 Distribution Panel or to the end of the Digital-supplied cable.

Paragraph 6.2.1.7, first sentence should read:

Remove the 7012894 test connector and install the BC08R cable (ADV11-A to H322 or H3220 Distribution Panel) or the BC04Z cable (ADV11-A to user devices) in the ADV11-A Berg connector.
pg 6-2 In the NOTE, the first sentence of the second paragraph should read:

To simplify system relationships, the H322 or H3320 Distribution Panel compensates for this inversion on the PC board that distributes Berg connector signals to front panel screw terminals.

pg 6-10 Paragraph 6.3.2, second sentence should read:

Install the BC08R cable (KWV11-A to H322 or H3220 Distribution Panel) or BC04Z cable (KWV11-A to user devices) between the Berg connector (J1) and the appropriate terminus.

pg 6-11 Paragraph 6.4.1.4, first sentence should read:

If AAV11-A signals are to be routed to the H322 or the H3220 Distribution Panel, connection may be made to the unit at this time. (See Paragraph 6.4.2.)

pg 6-11 Paragraph 6.4.2, first sentence should read:

Install the BC08R cable (AAV11-A to H322 or H3220 Distribution Panel) or BC04Z cable (AAV11-A to user devices) between the Berg connector (J1) and the appropriate terminus.